DENON



Please refer to the MODIFICATION NOTICE.

SERVICE MANUAL

MODEL	JP	E3	E2	EK	E2A	E1C	E1K	EUT
DRA-F107			\checkmark					
DRA-F107DAB				\checkmark				

AM-FM STEREO RECEIVER

• For purposes of improvement, specifications and design are subject to change without notice.

• Please use this service manual with referring to the operating instructions without fail.

• Some illustrations using in this service manual are slightly different from the actual set.



D&M Holdings Inc.

SAFETY PRECAUTIONS

The following check should be performed for the continued protection of the customer and service technician.

LEAKAGE CURRENT CHECK

Before returning the unit to the customer, make sure you make either (1) a leakage current check or (2) a line to chassis resistance check. If the leakage current exceeds 0.5 milliamps, or if the resistance from chassis to either side of the power cord is less than 460 kohms, the unit is defective.

CAUTION Please heed the points listed below during servicing and inspection.

○ Heed the cautions!

Spots requiring particular attention when servicing, such as the cabinet, parts, chassis, etc., have cautions indicated on labels or seals. Be sure to heed these cautions and the cautions indicated in the handling instructions.

◎ Caution concerning electric shock!

- (1) An AC voltage is impressed on this set, so touching internal metal parts when the set is energized could cause electric shock. Take care to avoid electric shock, by for example using an isolating transformer and gloves when servicing while the set is energized, unplugging the power cord when replacing parts, etc.
- (2)There are high voltage parts inside. Handle with extra care when the set is energized.

Caution concerning disassembly and assembly!

Though great care is taken when manufacturing parts from sheet metal, there may in some rare cases be burrs on the edges of parts which could cause injury if fingers are moved across them. Use gloves to protect your hands.

○ Only use designated parts!

The set's parts have specific safety properties (fire resistance, voltage resistance, etc.). For replacement parts, be sure to use parts which have the same properties. In particular, for the important safety parts that are marked \triangle on wiring diagrams and parts lists, be sure to use the designated parts.

Be sure to mount parts and arrange the wires as they were originally!

For safety reasons, some parts use tape, tubes or other insulating materials, and some parts are mounted away from the surface of printed circuit boards. Care is also taken with the positions of the wires inside and clamps are used to keep wires away from heating and high voltage parts, so be sure to set everything back as it was originally.

◎ Inspect for safety after servicing!

Check that all screws, parts and wires removed or disconnected for servicing have been put back in their original positions, inspect that no parts around the area that has been serviced have been negatively affected, conduct an insulation check on the external metal connectors and between the blades of the power plug, and otherwise check that safety is ensured.

(Insulation check procedure)

Unplug the power cord from the power outlet, disconnect the antenna, plugs, etc., and turn the power switch on. Using a 500V insulation resistance tester, check that the insulation resistance between the terminals of the power plug and the externally exposed metal parts (antenna terminal, headphones terminal, microphone terminal, input terminal, etc.) is $1M\Omega$ or greater. If it is less, the set must be inspected and repaired.

CAUTION Concerning important safety parts

Many of the electric and structural parts used in the set have special safety properties. In most cases these properties are difficult to distinguish by sight, and using replacement parts with higher ratings (rated power and withstand voltage) does not necessarily guarantee that safety performance will be preserved. Parts with safety properties are indicated as shown below on the wiring diagrams and parts lists is this service manual. Be sure to replace them with parts with the designated part number.

- (1) Schematic diagrams ... Indicated by the \triangle mark.
- (2) Parts lists ... Indicated by the \triangle mark.

Using parts other than the designated parts could result in electric shock, fires or other dangerous situations.

DIMENSION





WIRE ARRANGEMENT

If wire bundles are untied or moved to perform adjustment or parts replacement etc., be sure to rearrange them neatly as they were originally bundled or placed afterward.

Otherwise, incorrect arrangement can be a cause of noise generation.

Wire arrangement viewed from the top



Front Panel side



Back Panel side

DISASSEMBLY

- Disassemble in order of the arrow of the figure of following flow.
- In the case of the re-assembling, assemble it in order of the reverse of the following flow.



Please refer to "EXPLODED VIEW" for the disassembly method of each PCB.

CAUTION IN SERVICING Initializing DRA-F107/DRA-F107DAB

DRA-F107/DRA-F107DAB initialization should be performed when the μ com, and peripheral parts of μ com are replaced.

- 1. Switch off the unit and remove the AC cord from the wall outlet.
- 2. Hold the following the ◄ button and the AUTO PRESET button, and plug the AC cord into the outlet. Δ

Note: • All user settings will be lost and this factory setting will be recovered when this initialization mode. So make sure to m+emorize your setting for restoring after the initialization.

SPECIAL MODECD TEST MODE

No	Button name	Function	Display
S1	Version No. Display Mode	 S1.1 Plug AC cord into power outlet while pressing the ON/STANDBY button and the SDB/ TONE button same time on Main Unit. The Version number of MPU is displayed. MUTING ON Unplug AC cord to clear this mode. 	D R A
S1	Version No. Display Mode	 S1.2 When the iPod Dock is connected Plug AC cord into power outlet while pressing the ON/STANDBY button and the SDB/ TONE button same time on Main Unit. The Version number of MPU is displayed. MUTING ON Unplug AC cord to clear this mode. 	D R A I V E R I
S2	VFD checking mode	 Plug AC cord into power outlet while pressing the ON/STANDBY button and the AUTO PRESET button same time on Main Unit. All segment of FLD is turning on and off every one second . MUTING ON. Unplug AC cord to clear this mode. 	All segment turn on and off. Sob tone tuned auto st mono total random <5 i fld all sleep 9. O O O O O O O O O O O O O O O O O
S3	EEPROM testing Mode	 Plug AC cord into power outlet while pressing the ON/STANDBY button and the TUNER button same time on Main Unit. ON / STANDBY LED lighted ORANGE (The test is started). MUTING ON. When power LED lighted Green, this EEPROM test was OK. When power LED lighted RED, this EEPROM test was NG. Unplug AC cord to clear this mode. 	
S4	Cold start mode (Initialization)	 Plug AC cord into power outlet while pressing the AUTO PRESET button and the ◀ button same time on Main Unit. The system is reset. source CD/USB SDB OFF BASS O TREBLE O BALANCE CENTER DIMMER 100% VOLUME O Preset Frequency of TUNER: All 0 Main Unit ◄/► button: -/+ button for PRESET CLOCK 00:00(Flashing) AM12:00(Flashing)(E3) TIMER(EVERYDAY/ONCE): Timer Function CD Timer start time 0:00 (AM12:00 : E3) The system is reset, and once this is completed the unit is set to the normal mode. 	

TROUBLE SHOOTING

1. FLD dosen't light



2. POWER OFF with Blinking POWER LED



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3. System Connector(DENON BUS) don't work



4. The Key Operation don't work



5. The Remote Control Operation don't work



6. No Sound, Noise generated





to CD/USB in ★Mark

(4) DAB TUNER-in



to CD/USB in ★Mark

(6) PHONO PLAY



MEASURING POINT AND WAVEFORMS

MEASURING POINT FRONT PCB



UPDATE PCB









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POWER AMP



DAB PCB



WAVEFORMS

FLD Drive Signal •Mode:Fanction Select



DENON BUS •Mode:Push Remote Control "CD Play"



Remote Control

Mode: Push Remote Control "SOURCE"



CD/USB INPUT •Mode: Fanction Select Stopped @CLK @DATA @LATCH





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SEMICONDUCTORS

Only major semiconductors are shown, general semiconductors etc. are omitted to list. The semiconductor which described a detailed drawing in a schematic diagram are omitted to list.

1. IC's M3062LFGPGP (IC62)



M3062LFGPGP Terminal Function

Pin No.	Port Function	Port setting	Port Name	Explaanation	Output of Standby & Default
1	P94	0	[LED_RL]	[STANDBY Red LED output. ON:High]	L
2	P93	0	FL RESET	Reset output to FLD	L
3	TB2IN	I	FUNC_JOGB	FUNCTION encoder Pulse-B input	HI-Z
4	P91	0		Not Used:N.C.	L
5	TB0IN	Ι	FUNC_JOGA	FUNCTION encoder Pulse-A input	HI-Z
6	BYTE		(VSS)	GND	-
7	CNVSS	I	FLASH CNVss	Select input of Flash rom write mode	HI-Z
8	P87	0		Not Used:N.C.	L
9	P86	0		Not Used:N.C.	L
10	RESET	Ι	RESET	Reset input	HI-Z
11	XOUT		XTAL(16MHz)	Xtal output	-
12	VSS		(VSS)	GND	-
13	XIN		XTAL(16MHz)	Xtal input	-
14	VCC		(VCC)	Positive power	-
15	NMI	Ι	(PullUp)	Pull up	HI-Z
16	P84	0		Not Used:N.C.	L
17	INT1	INT	POWER KEY	Power button input (interrupt input)	HI-Z
18	INT0	INT	/DBRXD	DENON BUS Data input (interrupt input)	HI-Z
19	P81	I	50/60	50Hz/60Hz AC Input	HI-Z
20	P80	Ι	H/P SW	HEAD PHONE insert detect signal input	HI-Z
21	TA3IN	I	VOL JOGB	VOL encoder Pulse-B input	HI-Z
22	TA3OUT	I	VOL JOGA	VOL encoder Pulse-A input	HI-Z
23	P75	0	FLCS	Chip Select output to FLD	L
24	P74	0	LED G	POWER/SANDBY Green LED output. ON:High	L
25	P73	0	LED R	POWER/SANDBY Red LED output. ON:High	L
26	CLK2	0	/DBCLK(DENON BUS)	Serial Clock output for DENON BUS	н
27	RXD2	Ι	/DBRXD(DENON BUS)	Serial Data input for DENON BUS	HI-Z

28TXD20//DBTXD(DENON BUS)Serial Data output for DENON BUS29TXD3SOIPOD_TXSerial Data output for IPOD DOCK30RXD3SIIPOD_RXSerial Data input for IPOD DOCK31CLK1I(PULLDOWN)Pull down32P64ONot Used:N.C.33P63SOS1_DIN34P62SISI_DOUT35P61ONot Used:N.C.36P60ONot Used:N.C.37P57O.DNot Used:N.C.38P56ONot Used:N.C.39P55I(FLASH EPM)40P54SOE2P CLK41P53SIE2P DO42P52SOE2P DI43P51O(FLASH CE)44P50O(FLASH CE)45P47O46P46I47P45I48P44IP44IP44IP44IP44IP44PWB checkPull down	ut of Iby & ult
29TXD3SOIPOD_TXSerial Data output for IPOD DOCK30RXD3SIIPOD_RXSerial Data input for IPOD DOCKH31CLK1I(PULLDOWN)Pull downH32P64ONot Used:N.C.H33P63SOS1_DINSerial Data output to DAB ModuleH34P62SISI_DOUTSerial Data output from DAB ModuleH35P61ONot Used:N.C.H36P60ONot Used:N.C.H37P57O.DNot Used:N.C.H38P56ONot Used:N.C.H40P54SOE2P CLKSerial Data input from EEPROMH41P53SIE2P DOSerial Data output to EEPROMH44P50OImage: Chip Enable output to EEPROMH44P46IPWB checkPull downH47P45IPWB checkPull downH48P44IPWB checkPull downH	Н
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34P62SISI_DOUTSerial Data input from DAB Module35P61ONot Used:N.C.36P60ONot Used:N.C.37P57O.DNot Used:N.C.38P56ONot Used:N.C.39P55I(FLASH EPM)Not Used:N.C.40P54SOE2P CLKSerial Clock output to EEPROM41P53SIE2P DOSerial Data input from EEPROM42P52SOE2P DISerial Data output to EEPROM43P51OE2P CSChip Enable output to EEPROM44P50O(FLASH CE)Not Used:N.C.45P47ONot Used:N.C.46P46IPWB checkPull down48P44IPWB checkPull down	L
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41P53SIE2P DOSerial Data input from EEPROMH42P52SOE2P DISerial Data output to EEPROMH43P51OE2P CSChip Enable output to EEPROMH44P50O(FLASH CE)Not Used:N.C.H45P47ONot Used:N.C.H46P46IPWB checkPull downH47P45IPWB checkPull downH48P44IPWB checkPull downH	L
42P52SOE2P DISerial Data output to EEPROM43P51OE2P CSChip Enable output to EEPROM44P50O(FLASH CE)Not Used:N.C.45P47ONot Used:N.C.46P46IPWB checkPull down47P45IPWB checkPull down48P44IPWB checkPull down	1I-Z
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44 P50 O (FLASH CE) Not Used:N.C. 45 P47 O Not Used:N.C. Not Used:N.C. 46 P46 I PWB check Pull down H 47 P45 I PWB check Pull down H 48 P44 I PWB check Pull down H	L
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46P46IPWB checkPull downH47P45IPWB checkPull downH48P44IPWB checkPull downH	L
47 P45 I PWB check Pull down H 48 P44 I PWB check Pull down H	II-Z
48 P44 I PWB check Pull down	II-Z
	II-Z
49 P43 I PWB check Pull down	II-Z
50 P42 O Not Used:N.C.	L
51 P41 O Not Used:N.C.	L
52 P40 O Not Used:N.C.	L
53 P37 O /FMAM TUNER Select to DAB or AM/FM . DAB:High AM/FM:Low	L
54 P36 O TU/PHO REC.OUTPUT level Select to TU/PHO or Others . TU/PHO:High	L
55 P35 Q Not Used:N.C.	- L
56 P34 O Not Used:N.C.	
57 P33 O SW MUTE MUTE OUTPUT	н
58 P32 O Not Used:N.C.	L
59 P31 O TP.ON/OFF (TPOWER) AM/FM TUNER Power ON/OFF Switching output	- L
60 (VCC) Positive power	-
61 P30 O Not Used:N.C.	
62 (VSS) GND	-
63 P27 O Not Used N.C.	1
64 P26 I STEREO "STEREO" indicator input from EM/AM TUNER pack	
65 P25 I TUNED "TUNED" detect input from FM/AM TUNER pack	-11-7
66 P24 O TMUTE MUTE OUTPut for EM/AM TUNER pack	<u> </u>
67 P23 O SANYO CE Chip Enable output to PLL/RDS IC	-
68 P22 O SANYO DI Serial Data input to PLI /RDS IC	-
69 P21 O SANYO CI K Serial Clock output to PL / RDS IC	-
70 P20 I SANYO DO Serial Data output to PLL/RDS IC	
71 P17 I PROTECT2 Protect Signal input 2	
72 P16 O /SYR Reset output to RDS IC	··
73 INT3 INT REMOTE Remote Control signal input	-
74 P14 I PROTECTI/SP Protect Signal input 1 PROTECTION	<u>-</u> II-Z
75 P13 O /BUF EN Enable signal output fot BUS BUFFER IC	Н
76 P12 O VR MUTE MUTE OUTput for POWER AMP	H
77 P11 O RI (RMUTE) SPEAKER RELAY ON/OFF output	···
78 P10 O APON/OFF (APOWER) + 15V POM/EP ON/OFF Switching suitout ON/Ulight	-
	-
	-
	<u>-</u>

Pin No.	Port Function	Port setting	Port Name	Explaanation	Output of Standby & Default
82	P04	0	[RECOUT MUTE]	[MUTE output for REC.OUTPUT]	L
83	P03	0	M61531_DATA	Serial Data output to M61531	L
84	P02	0	M61531_CLK	Serial Clock output to M61531	L
85	P01	0	M61531_LATCH	Latch output to M61531	L
86	P00	Ι	PORT.IN_SW	PORTABL INPUT insert detect signal input	HI-Z
87	P107	I		Pull up	HI-Z
88	P106	I	USA	Initial Setting input	HI-Z
89	P105	I	EURO	Initial Setting input	HI-Z
90	P104	Ι		Pull up	L
91	AN3	AD	FREQ	Initial Setting input	HI-Z
92	AN2	AD	RDS	Initial Setting input	HI-Z
93	AN1	AD	KEY 0	Unit Operation Button input 0	HI-Z
94			(VSS)	GND	-
95	AN0	AD	KEY 1	Unit Operation Button input 1	HI-Z
96	VREF		(VCC)	Positive power	-
97	AVCC		(VCC)	Positive power	-
98	P96	0		Not Used:N.C.	L
99	P97	SO	FLDA	Serial Data output to FLD	L
100	P95	SO	FLCK	Serial Clock output to FLD	L

M61531FP (IC21)

Block Diagram and Pin Configuration (Top View)



Pin Description

Pin No.	Pin Name	Function
3, 1, 79, 77, 75, 73, 71, 69	INR2, 3, 4, 5, 6, 7, 8, 9	Input pin of R channel (Input Selector)
2, 80, 78, 76, 74, 72, 70, 68	INL2, 3, 4, 5, 6, 7, 8, 9	Input pin of L channel (Input Selector)
4	INL1/EXT INL	Input pin of L channel (Input Selector)/External Input pin(Lch)
5	INR1/EXT INR	Input pin of L channel (Input Selector)/External Input pin(Rch)
6, 13, 16, 19, 32, 57, 64	GND	Analog Ground
7, 24	CIN1/CIN2	Input pin of C channel (2 Input Selector)
8, 25	SWIN1/SWIN2	Input pin of SW channel (2 Input Selector)
9, 22	SRIN1/SRIN2	Input pin of SR channel (2 Input Selector)
10, 23	SLIN1/SLIN2	Input pin of SL channel (2 Input Selector)
11, 20	LIN1/LIN2	Input pin of L channel (2 Input Selector)
12, 21	RIN1/RIN2	Input pin of R channel (2 Input Selector)
14, 17	BALANCE L/+, R/+	Output pin of L/R channel Balance Output(+)
15, 18	LOUD L/BALANCE L/-,	Frequency characteristic setting pin of Loudness
	LOUD R/BALANCE R/-	/Output pin of L/R channel Balance Output(-)
26	DGND	Ground of internal logic circuit
27, 28, 29	CLOCK, DATA, LATCH	Input pin of control clock /data/ trigger
30	DVDD	Power supply to internal logic circuit
31	AVCC	Positive power supply to internal analog circuit
33	SWSELOUT	Output pin of SW channel volume input selector
34	SWVIN	Input pin of SW channel volume
35	SWOUT	Output pin of SW channel
36	COUT	Output pin of C channel
37	CVIN	Input pin of C channel volume
38	CSELOUT	Output pin of C channel volume input selector
39	SLSELOUT	Output pin of SL channel volume input selector
40	SLVIN	Input pin of SL channel volume
41	SLOUT	Output pin of SL channel
42	SROUT	Output pin of SR channel
43	SRVIN	Input pin of SR channel volume
44	SRSELOUT	Output pin of SR channel volume input selector
45	RSELOUT	Output pin of R channel volume input selector
46	RVIN	Input pin of R channel volume
47	ROUT	Output pin of R channel
51, 52, 50, 49	BASS L1, L2/BASS R1, R2	Frequency characteristic setting pin of tone control (BASS)
53, 48	TRE L/TRE R	Frequency characteristic setting pin of tone control (TREBLE)
54	LOUT	Output pin of L channel
55	LVIN	Input pin of L channel volume
56	LSELOUT	Output pin of L channel volume input selector
58, 60, 62/59, 61, 63	REC L1, L2, L3	Output pin of REC (Lch and Rch)
	/REC R1, R2, R3	
65	INL10/REC L4	Input pin of L channel (Input Selector)/Output pin of REC (Lch)
66	INR10/REC R4	Input pin of R channel (Input Selector)/Output pin of REC (Rch)
67	AVEE	Negative power supply to internal analog circuit



TAS5630DKD Block Diagram



TAS5630DKD Terminal Function

TERMINAL					
NAME	PHD NO.	DKD NO.	FUNCTION	DESCRIPTION	
AGND	8	10	Р	Analog ground	
BST_A	54	43	Р	HS bootstrap supply (BST), external 0.033 uF capacitor to OUT_A required.	
BST_B	41	34	Р	HS bootstrap supply (BST), external 0.033 uF capacitor to OUT_B required.	
BST_C	40	33	Р	HS bootstrap supply (BST), external 0.033 uF capacitor to OUT_C required.	
BST_D	27	24	Р	HS bootstrap supply (BST), external 0.033 uF capacitor to OUT_D required.	
/CLIP	18	-	0	Clipping warning; open drain; active low	
C_STARTUP	3	5	0	Startup ramp requires a charging capacitor of 4.7 nF to AGND in BTL mode.	
FREQ_ADJ	12	14	I	PWM frame rate programming pin requires resistor to AGND	
GND	7, 23, 24, 57, 58	9	Р	Ground	
GND_A	48, 49	38	Р	Power ground for half-bridge A	
GND_B	46, 47	37	Р	Power ground for half-bridge B	
GND_C	34, 35	30	Р	Power ground for half-bridge C	
GND_D	32, 33	29	Р	Power ground for half-bridge D	
GVDD_A	55	-	Р	Gate drive voltage supply requires 0.1 uF capacitor to GND A	
GVDD_B	56	-	Р	Gate drive voltage supply requires 0.1 uF capacitor to GND B	
GVDD_C	25	-	Р	Gate drive voltage supply requires 0.1 uF capacitor to GND C	
GVDD_D	26	-	Р	Gate drive voltage supply requires 0.1 uF capacitor to GND D	
 GVDD_AB	-	44	Р	Gate drive voltage supply requires 0.22 uF capacitor to GND A/GND B	
GVDD CD	-	23	Р	Gate drive voltage supply requires 0.22 uF capacitor to GND C/GND D	
INPUT A	4	6		Input signal for half bridge A	
INPUT B	5	7		Input signal for half bridge B	
INPUT C	10	12	Í	Input signal for half bridge C	
INPUT D	11	13	l I	Input signal for half bridge D	
 M1	20	20		Mode selection	
M2	21	21		Mode selection	
M3	22	22		Mode selection	
NC	59-62	-	-	No connect, pins may be grounded.	
OC ADJ	1	3	0	Analog over current programming pin requires resistor to ground.	
OSC IO+	13	15	I/O	Oscillaotor master/slave output/input.	
OSC IO-	14	16	I/O	Oscillaotor master/slave output/input.	
 /OTW	-	18	0	Overtemperature warning signal, open drain, active low.	
/OTW1	16	-	0	Overtemperature warning signal, open drain, active low.	
/OTW2	17	-	0	Overtemperature warning signal, open drain, active low.	
OUT A	52, 53	39, 40	0	Output, half bridge A	
OUT B	44, 45	36	0	Output, half bridge B	
	36, 37	31	0	Output, half bridge C	
OUT D	28, 29	27, 28	0	Output, half bridge D	
PSU REF	63	1	P	PSU Reference requires close decoupling of 330 pF to AGND	
PVDD_A	50, 51	41, 42	Р	Power supply input for half bridges A requires close decoupling of 2.2-uF capacitor to GND. A	
PVDD_B	42, 43	35	P	Power supply input for half bridges B requires close decoupling of 2.2-uF capacitor to GND B	
PVDD_C	38, 39	32	P	Power supply input for half bridges C requires close decoupling of 2.2-uF capacitor to GND. C.	
PVDD_D	30, 31	25, 26	Р	Power supply input for half bridges D requires close decoupling of 2.2-uF capacitor to GND D	
READY	19	19	0	Normal operation: open drain: active high	
/RESET	2	4		Device reset Input; active low, requires 47kOhm pull up resistor to VREG.	
/SD	15	17	0	Shutdown signal, open drain, active low	
VDD	64	2	P	Power supply for internal voltage regulator requires a 10-uF capacitor in parallel	
VI_CM	6	8	0	Analog comparator reference node requires close decoupling of	
	0	11			
				וותפורומו הפעטומנטו שטאטין וותפו אוו הפעטויפט ט. ו-ער כמאמכונטו נט אטאט	



Pin	Symbol	Function
1	ZC	Zero Crossing
2	REG	Regulation
3	CS	Primary Current Sensing
4, 5	HV	High Voltage input
6	OUT	gate driver out put
7	VCC	IC supply voltage
8	GND	Common ground

Blockdigram



3 Functional Description

3.1 VCC Pre-Charging and Typical VCC Voltage During Start-up

In the controller ICE2QS01, a power cell is integrated. As shown in Figure 2, the power cell consists of a high voltage device and a controller, whereby the high voltage device is controlled by the controller. The power cell provides a pre-charging of the VCC capacitor till VCC voltage reaches the VCC turned-on threshold $V_{\rm VCCon}$ and the IC begins to operate, while it may keep the VCC voltage at a constant value during burst mode operation when the output voltage is pulled down or the power from the auxiliary winding is not enough, or when the IC is latched off in certain protection mode.

Once the mains input voltage is applied, a rectified voltage shows across the capacitor C_{bus} . The high voltage device provides a current to charge the VCC capacitor C_{vcc} . Before the VCC voltage reaches a certain value, the amplitude of the current through the high voltage device is only determined by its channel resistance and can be as high as several mA. After the VCC voltage device so that a constant current around 1mA is provided to charge the VCC capacitor further, until the VCC voltage exceeds the turned-on threshold V_{VCCon} . As shown as the time phase I in Figure 3, the VCC voltage increase near linearly.



Figure 3 VCC voltage at start up

The time taking for the VCC pre-charging can then be approximately calculated as:

$$t_1 = \frac{V_{VCCon} \cdot C_{vcc}}{I_{VCCch \, arge2}}$$
[1]

where $I_{\text{VCCcharge2}}$ is the charging current from the power cell which is 1.05mA, typically.

Exceeds the VCC voltage the turned-on threshold V_{VCCon} of at time t_1 , the power cell is switched off, and the IC begins to operate with a soft-start. Due to power consumption of the IC and the fact that still no energy from the auxiliary winding to charge the VCC capacitor before the output voltage is built up, the VCC voltage

drops (Phase II). Once the output voltage is high enough, the VCC capacitor receives then energy from the auxiliary winding from the time point t_2 on. The VCC then will reach a constant value depending on output load.

Since there is a VCC undervoltage protection, the capacitance of the VCC capacitor should be selected to be high enough to ensure that enough energy is stored in the VCC capacitor so that the VCC voltage will never touch the VCC under voltage protection threshold V_{VCCUVP} before the output voltage is built up. Therefore, the capacitance should fulfill the following requirement:

$$C_{vcc} \ge \frac{I_{VCCop} \cdot (t_2 - t_1)}{V_{VCCon} - V_{VCCUVP}}$$
[2]

with $I_{\rm VCCop}$ the operating current of the controller.

3.2 Soft-start

At the time t_1 , the IC begins to operate with a soft-start. By this soft-start the switching stresses for the switch, diode and transformer are minimised. The soft-start implemented in the ICE2QS01 is a digital time-based function. The preset soft-start time is **24ms** with 8 steps. The internal reference for the regulation voltage begins at 1.35V and with an increment of 0.35V for each following step.

3.3 Normal Operation

The PWM section of the IC can be divided into two main portions: PWM controller for normal operation and PWM controller for burst mode operation. The PWM controller for normal operation will be described in the following paragraphs, while the PWM controller for burst mode operation will be discussed in the next section.

The PWM controller for normal operation consists of digital signal processing circuit including an up/down counter, a zero-crossing counter (ZC-counter) and a comparator, and analog circuit including a current measurement unit and a comparator. The switch-on and -off time point is determined by the digital circuit and the analog circuit, respectively. As input information for the switch-on determination, the zero-crossing input signal and the value of the up/down counter are needed, while the feedback signal v_{REG} and the current sensing signal v_{CS} are necessary for the switch-off determination. Details about the operation of the PWM controller in normal operation are illustrated in the following paragraphs.

3.3.1 Switch-on Determination

As mentioned above, the digital signal processing circuit consists of an up/down counter, a zero-crossing counter and a comparator. A ringing suppression time controller is implemented to avoid mistriggering by the ring after MOSFET is turned off. Functionality of these parts is described as in the following.

3.3.1.1 Up/down Counter

The up/down counter stores the number of zero crossing to be ignored before the main power switch is switched on after demagnetisation of the transformer. This value is a function of the regulation voltage, which contains information about the output power. Generally, a high output power results in a high regulation voltage. According to this information, the value in the up/down counter is changed to a low value in case of high regulation voltage, and to a high value in case of low regulation voltage. In ICE2QS01, the lowest value of the counter is 1 and the highest 7. Following text explains how the up/down counter value changes in responding to the regulation voltage v_{REG} . The regulation voltage v_{REG} is internally compared with three thresholds $V_{\rm RL}$, $V_{\rm RH}$ and $V_{\rm RM}$. According to the results, the value in the up/down counter is changed, which is summarised in Table 1 and Figure 4 respectively.

Table 1 Operation of the up/down counter

V _{REG}	up/down counter action
Always lower than V_{RL}	Count upwards till 7
Once higher than V _{RL} , but always lower than V _{RH}	Stop counting, no value changing
Once higher than V _{RH} , but always lower than V _{RM}	Count downwards till 1
Once higher than V _{RM}	Set up/down counter to 1



Figure 4 Up/down counter operation

According to the comparison results the up/down counter counts upwards, keeps unchanged or counts downwards. However, the value in up/down counter is

limited between 1 and 7. If the counter tends to count beyond this range, the attempt is ignored.

In normal case, the up/down counter can only be changed by one each time at the clock period of 48ms. However, to ensure a fast response to sudden load increase, the counter is set to 1 in the following switching period after the regulation voltage $v_{\rm REG}$ exceeds the threshold $V_{\rm RM}$.

3.3.1.2 Zero-Crossing Counter and Ringing Suppression Time Controller

In the system, the voltage from the auxiliary winding is applied to the zero-crossing pin through a RC network, which provides a time delay to the voltage from the auxiliary winding. Internally, this pin is connected to a clamping network, a zero-crossing detector, an output overvoltage (OP OVP) detector and a ringing suppression time controller.

During on-state of the power switch a negative voltage applies to the ZC pin. Through the internal clamping network, the voltage at the pin is clamped to certain level. However, it is highly recommended that a fast-recovery diode D_{zc} is added to block the negative voltage when the power switch is on. This is because the device in MOS technology is sensitive to negative voltage.

The voltage at the ZC pin v_{ZC} is compared with the threshold V_{ZCT1} . Once the voltage v_{ZC} crosses the threshold at its falling edge, a pulse is generated which is fed to the zero-crossing counter and the counter value increases by 1.

After MOSFET is turned on, there will be some oscillation on V_{DS} , which will also appear on the voltage on ZC pin. To avoid the MOSFET is turned on mistriggerred by such oscillation, a ringing suppression timer is implemented. The time is dependent on the voltage v_{ZC} . When the voltage v_{ZC} is lower than the threshold V_{ZCT2} , a longer preset time applies, while a shorter time is set when the voltage v_{ZC} is higher than the threshold.

The voltage v_{ZC} is used for the output overvoltage protection, as well. Once the voltage at this pin is higher than the threshold V_{OPOVP} during off-time of the main switch, the IC is latched off after a fixed blanking time.

To achieve the switch-on at voltage valley, the voltage from the auxiliary winding is fed to a time delay network (the RC network consists of D_{zc} , R_{zc1} , R_{zc2} and C_{zc} as shown in typical application circuit) before it is applied to the zero-crossing detector through the ZC pin. The needed time delay to the main oscillation signal Δt should be approximately one fourth of the oscillation period (by transformer primary inductor and drain-source capacitor) minus the propagation delay from the

detected zero-crossing to the switch-on of the main switch t_{delav} , theoretically:

$$\Delta t = \frac{T_{osc}}{4} - t_{delay}$$
[3]

This time delay should be matched by adjusting the time constant of the RC network which is calculated as:

$$\tau_{td} = C_{zc} \cdot \frac{R_{zc1} \cdot R_{zc2}}{R_{zc1} + R_{zc2}}$$
[4]

3.3.1.3 Switch-on Determination

In the system, turn-on of the power switch depends on the value of the up/down counter, the value of the zerocrossing counter and the voltage at the ZC pin v_{ZC} . Turn-on happens only when the value in the both counters are the same and the voltage at the ZC is lower than the threshold V_{ZCT1} . For comparison of the values from both counters, a digital comparator is used. Once these counters have the same value, the comparator generates a signal which sets the on/off flip-flop, only when the voltage v_{ZC} is lower than the threshold V_{ZCT1} .

Another signal which may trigger the digital comparator is the output of a T_{sMax} clock signal, which limits the maximum off time to avoid the low-frequency operation.

During active burst mode operation, the digital comparator is disabled and no pulse will be generated.

3.3.2 Switch-off Determination

In the converter system, the primary current is sensed by an external shunt resistor, which is connected between low-side terminal of the main power switch and the common ground. The sensed voltage across the shunt resistor $v_{\rm CS}$ is applied to an internal current measurement unit, and its output voltage v_1 is compared with the regulation voltage $v_{\rm reg}$. Once the voltage v_1 exceeds the voltage $v_{\rm REG}$, the output flip-flop is reset. As a result, the main power switch is switched off. The relationship between the v_1 and the $v_{\rm cs}$ is described by:

$$v_1 = 3.3 \cdot v_{CS} + 0.7$$
 [5]

To avoid mistriggering caused by the voltage spike across the shunt resistor after switch-on of the main power switch, a 330ns leading edge blanking time applies to output of the comparator.

3.3.3 Foldback Point Correction

In addition to the cycle-by-cylce primary current limitation, the IC incorporats a foldback point correction. The current limit on CS pin voltage is now a time dependent one. If the mains input voltage is high, the MOSFET on time will be short and the current limit will be low. In such a way, the maximum output power for the SMPS designed with ICE2QS01 will be nearly constant against the variations of mains input voltage. The current sense voltage limit versus the MOSFET maximum on time is shown in Figure 5.



Figure 5 Maximum current limit versus MOSFET maximum on time

3.4 Active Burst Mode Operation

At very low load condition, the IC enters active burst mode operation to minimize the input power. Details about active burst mode operation are explained in the following paragraphs.

3.4.1 Entering Active Burst Mode Operation

For determination of entering active burst mode operation, three conditions apply:

the regulation voltage is lower than the threshold of $V_{EB}(1.1V)$. Accordingly, the peak voltage across the shunt resistor is 0.11V;

the up/down counter has its maximal value of 7; and a certain blanking time (24ms).

Once all of these conditions are fulfilled, the active burst mode flip-flop is set and the controller enters burst mode operation. This multi-conditional determination for entering active burst mode operation prevents mistriggering of entering active burst mode operation, so that the controller enters active burst mode operation only when the output power is really low during the preset blanking time.

3.4.2 During Active Burst Mode Operation

After entering the Active Burst Mode the regulation voltage rises as V_{OUT} starts to decrease due to the inactive PWM section. One comparator observes the regulation signal if the voltage level V_{BH} (3.6V) is exceeded. In that case the internal circuit is again activated by the internal bias to start with swtiching.

Turn-on of the power MOSFET is triggered by the timer. The PWM generator for burst mode operation composes of a timer with a fixed frequency of 80kHz, typically, and an analog comparator. Turn-off is resulted by comparison of the voltage signal v₁ with an internal threshold, by which the voltage across the shunt resistor V_{cSB} is 0.25V, accordingly. A turn-off can also be triggered by the maximal duty ratio controller which sets the maximal duty ratio to 50%. In operation, the output flip-flop will be reset by one of these signals which come first.

If the output load is still low, the regulation signal decreases as the PWM section is operating. When regulation signal reaches the low threshold $V_{BL}(3.0V)$, the internal bias is reset again and the PWM section is disabled until next time regulation siganl increases beyond the V_{BH} threshold. If working in active burst mode the regulation signal is changing like a saw tooth between 3.0V and 3.6V shown in Figure 6.

3.4.3 Leaving Active Burst Mode

The regulation voltage immediately increases if there is a high load jump. This is observed by one comparator. As the current limit is 25% during active burst mode a certain load is needed so that regulation voltage can exceed V_{LB} (4.5V). After leaving active busrt mode, maximum current can now be provided to stabilize V_0 . In addition, the up/down counter will be set to 1 immediately after leaving active burst mode. This is helpful to decrease the output voltage undershoot.

3.4.4 IC Power Supply During Active Burst Mode

During active burst mode operation, the power cell is activated again. Once the power from the auxiliary winding is not high enough to keep the VCC voltage above the preset value of $V_{\rm VCCBL}$, the power cell keeps the VCC voltage at the preset value $V_{\rm VCCBL}$. Otherwise, if the VCC voltage is still above this value, no current flows through the power cell though it is activated.



Figure 6 Signals in active burst mode

3.5 **Protection Functions**

The IC provides full protection functions. The following table summarizes these protection functions.

Table 2Protection features

VCC Overvoltage	Auto Restart Mode
VCC Undervoltage	Auto Restart Mode
Overload/Open Loop	Auto Restart Mode
Output Overvoltage	Latched Off Mode
Short Winding	Latched Off Mode

During operation, the VCC voltage is continuously monitored. In case of an under- or an over-voltage, the IC is reset and the main power switch is then kept off. After the VCC voltage falls below the threshold V_{VCCUVP} , the power cell is activated. The VCC capacitor is then charged up. Once the voltage exceeds the threshold V_{VCCon} , the IC begins to operate with a new soft-start.

In case of open control loop or output over load, the regulation voltage will be pulled up . After a blanking time of 24ms, the IC enters auto-restart mode. The blanking time here enables the converter to provide a high power in case the increase in V_{REG} is due to a sudden load increase. During off-time of the power switch, the voltage at the zero-crossing pin is monitored for output over-voltage detection. If the voltage is higher than the preset threshold v_{OPOVP} , the IC is latched off after the preset blanking time.

If the voltage at the current sensing pin is higher than the preset threshold $v_{\rm csSW}$ during on-time of the power switch, the IC is latched off. This is short-winding protection.

During latch-off protection mode, the power cell is activated and it keeps the VCC voltage at the level of $V_{\rm VCCBL.}$

4 Electrical Characteristics

Note: All voltages are measured with respect to ground (Pin 8). The voltage levels are valid if other ratings are not violated.

4.1 Absolute Maximum Ratings

Note: Absolute maximum ratings are defined as ratings, which when being exceeded may lead to destruction of the integrated circuit. For the same reason make sure, that any capacitor that will be connected to pin 7 (VCC) is discharged before assembling the application circuit.

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
HV Voltage	V _{HV}	-	500	V	
VCC Supply Voltage	V _{VCC}	-0.3	27	V	
REG Voltage	V _{REG}	-0.3	5.0	V	
ZC Voltage	V _{ZC}	-0.3	5.0	V	
CS Voltage	V _{CS}	-0.3	5.0	V	
OUT Voltage	V _{OUT}	-0.3	27	V	
Junction Temperature	Tj	-40	125	°C	
Storage Temperature	Ts	-55	150	°C	
Thermal Resistance Junction-Ambient	R _{thJA}	-	90	K/W	PG-DIP-8
ESD Capability	V _{ESD}	-	2	kV	Human body model ¹⁾

¹⁾ According to EIA/JESD22-A114-B (discharging a 100pF capacitor through a $1.5k\Omega$ series resistor)

4.2 Operating Range

Note: Within the operating range the IC operates as described in the functional description.

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
VCC Supply Voltage	V _{VCC}	V _{VCCUVP}	V _{VCCOVP}	V	
Junction Temperature	T _{jCon}	-25	125	°C	

4.3 Characteristics

4.3.1 Supply Section

Note: The electrical characteristics involve the spread of values guaranteed within the specified supply voltage and junction temperature range T_J from – 25 °C to 125°C. Typical values represent the median values, which are related to 25°C. If not otherwise stated, a supply voltage of V_{CC} = 18 V is assumed.

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Start-Up Current	I _{VCCstart}	-	300	550	μA	V _{VCC} = 21V
VCC Charge Current	I _{VCCcharge1}			5.0	mA	V _{VCC} = 0V
	I _{VCCcharge2}	0.55	1.05	1.60	mA	V _{VCC} = 1V
	I _{VCCcharge3}	-	0.88	-	mA	V _{VCC} = 21V
Leakage Current of Power Cell	I _{StartLeak}	-	0.2	50	μA	V _{HV} = 610V at T _j = 100°C
Supply Current in normal operation	I _{VCCop}	-	2.5	3.6	mA	Output low
Supply Current in Auto Restart Mode with Inactive Gate	I _{VCCrestart}	-	300	-	μA	
Supply Current in Latch-off Mode	I _{VCClatch}	-	300	-	μA	
Supply Current in Burst Mode with Inactive Gate	I _{VCCburst}	-	500	950	μA	V _{REG} = 2.5V
Supply Voltage with no power from auxiliary winding in burst mode or in latch-off mode	V _{VCCBL}	-	12.5	-	V	V _{HV} = 100V
VCC Turn-On Threshold	V _{VCCon}	21.2	22.0	22.8	V	
Internal Reference Voltage	V _{REF}	4.8	5.0	5.2	V	measured at pin REG, I _{REG} = 0

4.3.2 PWM Section

Parameter	Symbol		Limit Values			Test Condition
		min.	typ.	max.		
Regulation Pull-Up Resistor	R _{REG}	14	23	33	kΩ	
PWM-OP Gain	A _V	3.18	3.3	-	-	
Offset for Voltage Ramp	V _{os}	0.63	0.7	-	V	
Soft-Start time	t _{SOFTS}	18	21	38	ms	
Zero crossing threshold voltage	V _{ZCT1}	20	50	110	mV	
Ringing suppression threshold	V _{ZCT2}		0.7		V	
Minimum ringing suppression time	t _{ZCRST1}	2.2	4.2	5.5	μs	$V_{ZC} > V_{ZCT2}$
Maximum ringing suppression time	t _{ZCRST2}	-	42	-	μs	V _{ZC} < V _{ZCT2}
Threshold to set Up/Down Counter to one	V _{RM}		3.9		V	
Threshold for downward counting	V _{RH}		3.2		V	
Threshold for upward counting	V _{RL}		2.5		V	
Counter time ¹⁾	t _{COUNT}		48		ms	
Maximum restart time in normal operation	t _{sMax}	33	42	60	μs	V _{ZC} <v<sub>ZCT1</v<sub>
Leading Edge Blanking	t _{LEB}	200	330	460	ns	
Peak current limitation in normal operation	V _{csth}	0.95	1.0	1.05	V	
Regulation voltage for entering Burst Mode	V _{EB}		1.1		V	
Regulation voltage for leaving Burst Mode	V _{LB}		4.5		V	
Regulation voltage for burst-on	V _{BH}		3.6		V	
Regulation voltage for burst-off	V _{BL}		3.0		V	
Fixed Switching Frequency in Burst Mode	f _{sB}	64	80	96	kHz	
Max. Duty Cycle in Burst Mode	D _{maxB}		0.5			
Peak Current Limitation in Burst Mode	V _{csB}	0.22	0.25	0.3	V	
1) The parameter is not subject	to production	n test - ver	ified by de	sign/chara	acterizatio	n

4.3.3 Protection

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
VCC overvoltage threshold	V _{VCCOVP}	24	25.0	26	V	
VCC undervoltage threshold	V _{VCCUVP}	10.3	11.0	11.7	V	
Over Load or Open Loop Detection threshold for OLP protection at REG pin	V _{OLP}		4.5		V	
Over Load or Open Loop Protection Blanking Time	T _{OLP-B}	16	24	35	ms	
Output Overvoltage detection threshold at the ZC pin	V _{OPOVP}		4.5		V	
Threshold for short winding protection	V _{csSW}		1.68		V	

Note: The trend of all the voltage levels in the Control Unit is the same regarding the deviation except V_{VCCOVP}

4.3.4 Gate Driver

Parameter	Symbol	Limit Values		es	Unit	Test Condition
		min.	typ.	max.		
Output voltage at logic low	V _{GATElow}		0.7		V	I _{OUT} = 20mA
Output voltage at logic high	V _{GATEhigh}		10.0		V	I _{OUT} = -20mA
Output voltage active shut down	V_{GATEasd}		1.0		V V	V _{VCC} = 7V I _{OUT} = 20mA
Rise Time	t _{rise}	-	100	-	ns	C _{OUT} = 4.7nF
Fall Time	t _{fall}	-	25	-	ns	C _{OUT} = 4.7nF


DRA-F107 / DRA-F107DAB

3 Functional Description

3.1 Power Management



Figure 6 Power Management

The Undervoltage Lockout monitors the external supply voltage V_{VCC} . In case the IC is inactive the current consumption is max. 55µA. When the SMPS is plugged to the main line the current through R_{Start-up} charges the external Capacitor C_{VCC}. When V_{VCC} exceeds the on-threshold V_{CCon}=13.5V the internal bias circuit and the voltage reference are switched on. After that the internal bandgap generates a reference voltage V_{REF}=6.5V to supply the internal circuits. To avoid uncontrolled ringing at switch-on a hysteresis is implemented which means that switch-off is only after active mode when Vcc falls below 8.5V.

In case of switch-on a Power Up Reset is done by resetting the internal error-latch in the protection unit.

When V_{VCC} falls below the off-threshold V_{CCoff}=8.5V the internal reference is switched off and the Power Down reset let T1 discharging the soft-start capacitor C_{Soft-Start} at pin SoftS. Thus it is ensured that at every switch-on the voltage ramp at pin SoftS starts at zero.

3.2 Improved Current Mode



Figure 7 Current Mode

Current Mode means that the duty cycle is controlled by the slope of the primary current. This is done by comparison the FB signal with the amplified current sense signal.



Figure 8 Pulse Width Modulation

In case the amplified current sense signal exceeds the FB signal the on-time T_{on} of the driver is finished by resetting the PWM-Latch (see Figure 8).

The primary current is sensed by the external series resistor R_{Sense} inserted in the source of the integrated CoolMOSTM. By means of Current Mode regulation, the

secondary output voltage is insensitive on line variations. Line variation changes the current waveform slope which controls the duty cycle.

The external R_{Sense} allows an individual adjustment of the maximum source current of the integrated CoolMOSTM.



Figure 9 Improved Current Mode

To improve the Current Mode during light load conditions the amplified current ramp of the PWM-OP is superimposed on a voltage ramp, which is built by the switch T_2 , the voltage source V_1 and the 1st order low pass filter composed of R_1 and C_1 (see Figure 9, Figure 10). Every time the oscillator shuts down for max. duty cycle limitation the switch T2 is closed by V_{OSC} . When the oscillator triggers the Gate Driver T2 is opened so that the voltage ramp can start.

In case of light load the amplified current ramp is to small to ensure a stable regulation. In that case the Voltage Ramp is a well defined signal for the comparison with the FB-signal. The duty cycle is then controlled by the slope of the Voltage Ramp.

By means of the Comparator C5, the Gate Driver is switched-off until the voltage ramp exceeds 0.3V. It allows the duty cycle to be reduced continuously till 0% by decreasing V_{FB} below that threshold.



Figure 10 Light Load Conditions

3.2.1 **PWM-OP**

The input of the PWM-OP is applied over the internal leading edge blanking to the external sense resistor R_{Sense} connected to pin Isense. R_{Sense} converts the source current into a sense voltage. The sense voltage is amplified with a gain of 3.65 by PWM OP. The output of the PWM-OP is connected to the voltage source V1. The voltage ramp with the superimposed amplified current signal is fed into the positive inputs of the PWM-Comparator, C5 and the Soft-Start-Comparator.

3.2.2 PWM-Comparator

The PWM-Comparator compares the sensed current signal of the integrated CoolMOSTM with the feedback signal V_{FB} (see Figure 11). V_{FB} is created by an external optocoupler or external transistor in combination with the internal pull-up resistor R_{FB} and provides the load information of the feedback circuitry. When the amplified current signal of the integrated CoolMOSTM exceeds the signal V_{FB} the PWM-Comparator switches off the Gate Driver.



Figure 11 PWM Controlling

3.3 Soft-Start



Figure 12 Soft-Start Phase

The Soft-Start is realized by the internal pull-up resistor $R_{Soft-Start}$ and the external Capacitor $C_{Soft-Start}$ (see Figure 5). The Soft-Start voltage V_{SoftS} is generated by charging the external capacitor $C_{Soft-Start}$ by the internal

Functional Description

pull-up resistor R_{Soft-Start}. The Soft-Start-Comparator compares the voltage at pin SoftS at the negative input with the ramp signal of the PWM-OP at the positive input. When Soft-Start voltage $V_{\rm SoftS}$ is less than Feedback voltage $V_{\rm FB}$ the Soft-Start-Comparator limits the pulse width by resetting the PWM-Latch (see Figure 12). In addition to Start-Up, Soft-Start is also activated at each restart attempt during Auto Restart. By means of the above mentioned $C_{\text{Soft-Start}}$ the Soft-Start can be defined by the user. The Soft-Start is finished when V_{SoftS} exceeds 5.3V. At that time the Protection Unit is activated by Comparator C4 and senses the FB by Comparator C3 wether the voltage is below 4.8V which means that the voltage on the secondary side of the SMPS is settled. The internal Zener Diode at SoftS has a clamp voltage of 5.6V to prevent the internal circuit from saturation (see Figure 13).



Figure 13 Activation of Protection Unit

The Start-Up time $T_{Start-Up}$ within the converter output voltage V_{OUT} is settled must be shorter than the Soft-Start Phase $T_{Soft-Start}$ (see Figure 14).

$$C_{Soft-Start} = \frac{T_{Soft-Start}}{R_{Soft-Start} \times 1.69}$$

By means of Soft-Start there is an effective minimization of current and voltage stresses on the integrated CoolMOS[™], the clamp circuit and the output overshoot and prevents saturation of the transformer during Start-Up.



Figure 14 Start Up Phase

3.4 Oscillator and Frequency Reduction

3.4.1 Oscillator

The oscillator generates a frequency $f_{switch} = 67 kHz/100 kHz$. A resistor, a capacitor and a current source and current sink which determine the frequency are integrated. The charging and discharging current of the implemented oscillator capacitor are internally trimmed, in order to achieve a very accurate switching frequency. The ratio of controlled charge to discharge current is adjusted to reach a max. duty cycle limitation of D_{max} =0.72.

3.4.2 Frequency Reduction

The frequency of the oscillator is depending on the voltage at pin FB. The dependence is shown in Figure 15. This feature allows a power supply to operate at lower frequency at light loads thus lowering the switching losses while maintaining good cross regulation performance and low output ripple. In case of low power the power consumption of the whole SMPS can now be reduced very effective. The minimal reachable frequency is limited to 20kHz/21.5 kHz to avoid audible noise in any case.



Figure 15 Frequency Dependence

3.5 Current Limiting

There is a cycle by cycle current limiting realized by the Current-Limit Comparator to provide an overcurrent detection. The source current of the integrated CoolMOS[™] is sensed via an external sense resistor R_{Sense} . By means of R_{Sense} the source current is transformed to a sense voltage V_{Sense} . When the voltage V_{Sense} exceeds the internal threshold voltage V_{csth} the Current-Limit-Comparator immediately turns off the gate drive. To prevent the Current Limiting from distortions caused by leading edge spikes a Leading Edge Blanking is integrated at the Current Sense. Furthermore a Propagation Delay Compensation is added to support the immediate shut down of the CoolMOS[™] in case of overcurrent.

3.5.1 Leading Edge Blanking



Figure 16 Leading Edge Blanking

Each time when CoolMOSTM is switched on a leading spike is generated due to the primary-side capacitances and secondary-side rectifier reverse recovery time. To avoid a premature termination of the switching pulse this spike is blanked out with a time constant of t_{LEB} = 220ns. During that time the output of

the Current-Limit Comparator cannot switch off the gate drive.

3.5.2 Propagation Delay Compensation

In case of overcurrent detection by I_{Limit} the shut down of CoolMOSTM is delayed due to the propagation delay of the circuit. This delay causes an overshoot of the peak current I_{peak} which depends on the ratio of dl/dt of the peak current (see Figure 17).



Figure 17 Current Limiting

The overshoot of Signal2 is bigger than of Signal1 due to the steeper rising waveform.

A propagation delay compensation is integrated to bound the overshoot dependent on dl/dt of the rising primary current. That means the propagation delay time between exceeding the current sense threshold V_{csth} and the switch off of CoolMOSTM is compensated over temperature within a range of at least.

$$0 \le R_{Sense} \times \frac{dI_{peak}}{dt} \le \frac{dV_{Sense}}{dt}$$



Figure 18 Dynamic Voltage Threshold V_{csth}

The propagation delay compensation is done by means of a dynamic threshold voltage V_{csth} (see Figure 18). In case of a steeper slope the switch off of the driver is earlier to compensate the delay.

E.g. $I_{peak} = 0.5A$ with $R_{Sense} = 2$. Without propagation delay compensation the current sense threshold is set to a static voltage level V_{csth} =1V. A current ramp of dl/dt = 0.4A/µs, that means $dV_{Sense}/dt = 0.8V/µs$, and a propagation delay time of i.e. $t_{Propagation \ Delay}$ =180ns leads then to a I_{peak} overshoot of 14.4%. By means of propagation delay compensation the overshoot is only about 2% (see Figure 19).



Figure 19 Overcurrent Shutdown

3.6 PWM-Latch

The oscillator clock output applies a set pulse to the PWM-Latch when initiating CoolMOS[™] conduction. After setting the PWM-Latch can be reset by the PWM-OP, the Soft-Start-Comparator, the Current-Limit-Comparator, Comparator C3 or the Error-Latch of the Protection Unit. In case of resetting the driver is shut down immediately.

3.7 Driver

The driver-stage drives the gate of the CoolMOS[™] and is optimized to minimize EMI and to provide high circuit efficiency. This is done by reducing the switch on slope when reaching the CoolMOS[™] threshold. This is achieved by a slope control of the rising edge at the driver's output (see Figure 20) to the CoolMOS[™] gate. Thus the leading switch on spike is minimized. When CoolMOS[™] is switched off, the falling shape of the driver is slowed down when reaching 2V to prevent an overshoot below ground. Furthermore the driver circuit is designed to eliminate cross conduction of the output stage. At voltages below the undervoltage lockout threshold V_{VCCoff} the gate drive is active low.



Figure 20 Internal Gate Rising Slope

3.8 Protection Unit (Auto Restart Mode)

An overload, open loop and overvoltage detection is integrated within the Protection Unit. These three failure modes are latched by an Error-Latch. Additional thermal shutdown is latched by the Error-Latch. In case of those failure modes the Error-Latch is set after a blanking time of 5µs and the CoolMOS[™] is shut down. That blanking prevents the Error-Latch from distortions caused by spikes during operation mode.

3.8.1 Overload / Open Loop with Normal Load

Figure 21 shows the Auto Restart Mode in case of overload or open loop with normal load. The detection of open loop or overload is provided by the Comparator C3, C4 and the AND-gate G2 (see Figure 22). The detection is activated by C4 when the voltage at pin SoftS exceeds 5.3V. Till this time the IC operates in the Soft-Start Phase. After this phase the comparator C3 can set the Error-Latch in case of open loop or overload which leads the feedback voltage V_{FB} to exceed the threshold of 4.8V. After latching VCC decreases till 8.5V and inactivates the IC. At this time the external Soft-Start capacitor is discharged by the internal transistor T1 due to Power Down Reset. When the IC is inactive V_{VCC} increases till V_{CCon} = 13.5V by charging the Capacitor C_{VCC} by means of the Start-Up Resistor R_{Start-Up}. Then the Error-Latch is reset by Power Up Reset and the external Soft-Start capacitor $C_{Soft-Start}$ is charged by the internal pull-up resistor $R_{\text{Soft-Start}}.$ During the Soft-Start Phase which ends when the voltage at pin SoftS exceeds 5.3V the detection of overload and open loop by C3 and G2 is inactive. In this way the Start Up Phase is not detected as an overload.



Figure 21 Auto Restart Mode



Figure 22 FB-Detection

Functional Description

But the Soft-Start Phase must be finished within the Start Up Phase to force the voltage at pin FB below the failure detection threshold of 4.8V.

3.8.2 Overvoltage due to Open Loop with No Load



Figure 23 Auto Restart Mode

Figure 23 shows the Auto Restart Mode for open loop and no load condition. In case of this failure mode the converter output voltage increases and also VCC. An additional protection by the comparators C1, C2 and the AND-gate G1 is implemented to consider this failure mode (see Figure 24).The overvoltage detection is provided by Comparator C1 only in the first time during the Soft-Start Phase till the Soft-Start voltage exceeds the threshold of the Comparator C2 at 4.0V and the voltage at pin FB is above 4.8V. When VCC exceeds 16.5V during the overvoltage detection phase C1 can set the Error-Latch and the Burst Phase during Auto Restart Mode is finished earlier. In that case T_{Burst2} is shorter than $T_{Soft-Start}$. By means of C2 the normal operation mode is prevented from overvoltage detection due to varying of VCC concerning the regulation of the converter output. When the voltage V_{SoftS} is above 4.0V the overvoltage detection by C1 is deactivated.



Figure 24 Overvoltage Detection

3.8.3 Thermal Shut Down

Thermal Shut Down is latched by the Error-Latch when junction temperature T_j of the pwm controller is exceeding an internal threshold of 140°C. In that case the IC switches in Auto Restart Mode.

Note: All the values which are mentioned in the functional description are typical. Please refer to Electrical Characteristics for min/max limit values.

4 Electrical Characteristics

4.1 Absolute Maximum Ratings

Note: Absolute maximum ratings are defined as ratings, which when being exceeded may lead to destruction of the integrated circuit. For the same reason make sure, that any capacitor that will be connected to pin 6 (VCC) is discharged before assembling the application circuit.

Parameter		Symbol	Lim	it Values	Unit	Remarks
			min.	max.		
Drain Source Voltage ICE2A0565/165/265/3 ICE2B0565/165/265/3 ICE2A0565G ICE2A0565Z	65/765I/765P2 65/765I/765P2	V _{DS}	-	650	V	<i>T</i> _j = 110°C
Drain Source Voltage ICE2A180Z/280Z/380P2		V _{DS}	-	800	V	$T_{\rm j} = 25^{\circ}{\rm C}$
LE2A180Z/280Z/380P2 ulsed drain current, limited by T_{jmax} ICE2A0565/ ICE2A0565G/ ICE2A0565Z		I _{D_Puls1}		2.0	A	
ICE2A05052 ICE2A165/ ICE2B165		I _{D_Puls2}		3.8	A	
	ICE2A265/ ICE2B265	I _{D_Puls3}		9.8	A	
	ICE2A365/ ICE2B365	I _{D_Puls4}		23.3	A	
	ICE2A180Z	I _{D_Puls5}		4.1	A	
	ICE2A280Z	I _{D_Puls6}		14.8	A	
	ICE2A765P2/ ICE2B765P2/ ICE2A765I/ ICE2B765I	I _{D_Puls7}		19.0	A	
	ICE2A380P2/	I _{D_Puls8}		5.7	А	

Electrical Characteristics

Parameter		Symbol	Limit	Values	Unit	Remarks
			min.	max.		
Avalanche energy,	ICE2A0565	E _{AR1}	-	0.01	mJ	
repetitive t_{AR} limited by max. $T_i=150^{\circ}C^{1}$	ICE2A165	E _{AR2}	-	0.07	mJ	
	ICE2A265	E _{AR3}	-	0.40	mJ	
	ICE2A365	E _{AR4}	-	0.50	mJ	
	ICE2B0565	E _{AR5}	-	0.01	mJ	
	ICE2B165	E _{AR6}	-	0.07	mJ	
	ICE2B265	E _{AR7}	-	0.40	mJ	
	ICE2B365	E _{AR8}	-	0.50	mJ	
	ICE2A0565G	E _{AR9}	-	0.01	mJ	
	ICE2A0565Z	E _{AR10}	-	0.01	mJ	
	ICE2A180Z	E _{AR11}	-	0.07	mJ	
	ICE2A280Z	E _{AR12}	-	0.40	mJ	
	ICE2A765I	E _{AR13}	-	0.50	mJ	
	ICE2B765I	E _{AR14}	-	0.50	mJ	
	ICE2A765P2	E _{AR15}	-	0.50	mJ	
	ICE2B765P2	E _{AR16}	-	0.50	mJ	
	ICE2A380P2	E _{AR17}	-	0.06	mJ	

¹⁾ Repetitive avalanche causes additional power losses that can be calculated as $P_{AV} = E_{AR}^* f$

Parameter		Symbol	Limi	t Values	Unit	Remarks
			min.	max.		
Avalanche current,	ICE2A0565	I _{AR1}	-	0.5	А	
repetitive tAR limited by max $T=150^{\circ}$ C	ICE2A165	I _{AR2}	-	1	А	
	ICE2A265	I _{AR3}	-	2	А	
	ICE2A365	I _{AR4}	-	3	А	
	ICE2B0565	I _{AR5}	-	0.5	А	
	ICE2B165	I _{AR6}	-	1	А	
	ICE2B265	I _{AR7}	-	2	А	
	ICE2B365	I _{AR8}	-	3	А	
	ICE2A0565G	I _{AR9}	-	0.5	А	
	ICE2A0565Z	I _{AR10}	-	0.5	А	
	ICE2A180Z	I _{AR11}	-	1	А	
	ICE2A280Z	I _{AR12}	-	2	А	
	ICE2A765I	I _{AR13}	-	7	А	
	ICE2B765I	I _{AR14}	-	7	А	
	ICE2A765P2	I _{AR15}	-	7	А	
	ICE2B765P2	I _{AR16}	-	7	А	
	ICE2A380P2	I _{AR17}	-	2.4	А	
V _{CC} Supply Voltage		V _{cc}	-0.3	22	V	
FB Voltage		V _{FB}	-0.3	6.5	V	
SoftS Voltage		V _{SoftS}	-0.3	6.5	V	
I _{Sense}		I _{Sense}	-0.3	3	V	
Junction Temperature Storage Temperature Thermal Resistance		T _j	-40	150	°C	Controller & CoolMOS™
		Ts	-50	150	°C	
		R _{thJA1}	-	90	K/W	PG-DIP-8-6
Junction-Ambient		R _{thJA2}	-	96	K/W	PG-DIP-7-1
		R _{thJA3}	-	110	K/W	P-DSO-16/12
ESD Robustness ¹⁾		V _{ESD}	-	2 ²⁾	kV	Human Body Model

 $^{1)}\;$ Equivalent to discharging a 100pF capacitor through a 1.5 k Ω series resistor

 $^{\rm 2)}~$ 1kV at pin drain of ICE2x0565, ICE2A0565Z and ICE2A0565G

Electrical Characteristics

Parameter		Symbol	Limit	Values	Unit	Remarks
			min.	max.		
Thermal Resistance Junction-Ambient	ICE2A765I ICE2B765I ICE2A765P2 ICE2B765P2	R _{thJA4}	-	74	K/W	Free standing with no heat-sink
ICE28765P		R _{thJA5}	-	82	K/W	
Junction-Case	ICE2A765I ICE2B765I ICE2A765P2 ICE2B765P2	R _{thJC1}	-	2.5	K/W	
	ICE2A380P2	R _{thJC2}	-	2.86	K/W	

4.2 Thermal Impedance (ICE2X765I and ICE2X765P2)

4.3 Operating Range

Note: Within the operating range the IC operates as described in the functional description.

Parameter	Symbol	Limit	Values	Unit	Remarks
		min.	in. max.		
V _{CC} Supply Voltage	V _{cc}	V _{CCoff}	21	V	
Junction Temperature of Controller	T _{JCon}	-25	130	°C	Limited due to thermal shut down of controller
Junction Temperature of CoolMOS™	T _{JCoolMOS}	-25	150	°C	

4.4 Characteristics

Note: The electrical characteristics involve the spread of values given within the specified supply voltage and junction temperature range T_J from – 25 °C to 125 °C. Typical values represent the median values, which are related to 25 °C. If not otherwise stated, a supply voltage of V_{CC} = 15 V is assumed.

4.4.1 Supply Section

Parameter		Symbol		Limit Val	ues	Unit	Test Condition
			min.	typ.	max.		
Start Up Current		I _{VCC1}	-	27	55	μA	$V_{\rm CC} = V_{\rm CCon} - 0.1 V$
Supply Current w Gate	ith Inactive	I _{VCC2}	-	5.0	6.6	mA	$V_{\text{SoftS}} = 0$ $I_{\text{FB}} = 0$
Supply Current	ICE2A0565	I _{VCC3}	-	5.3	6.7	mA	$V_{\text{SoftS}} = 5V$
with Active Gate	ICE2A165	I _{VCC4}	-	6.5	7.8	mA	$I_{\rm FB} = 0$
	ICE2A265	I _{VCC5}	-	6.7	8.0	mA	
	ICE2A365	I _{VCC6}	-	8.5	9.8	mA	
	ICE2B0565	I _{VCC7}	-	5.2	6.7	mA	
	ICE2B165	I _{VCC8}	-	5.5	7.0	mA	
	ICE2B265	I _{VCC9}	-	6.1	7.3	mA	
	ICE2B365	I _{VCC10}	-	7.1	8.3	mA	
	ICE2A0565G	I _{VCC11}	-	5.3	6.7	mA	
	ICE2A0565Z	I _{VCC12}	-	5.3	6.7	mA	
	ICE2A180Z	I _{VCC13}	-	6.5	7.8	mA	
	ICE2A280Z	I _{VCC14}	-	7.7	9.0	mA	
Supply Current	ICE2A765I	I _{VCC15}	-	8.5	9.8	mA	$V_{\text{SoftS}} = 5V$
with Active Gate	ICE2B765I	I _{VCC16}	-	7.1	8.3	mA	$I_{\rm FB} = 0$
	ICE2A765P2	I _{VCC17}	-	8.5	9.8	mA	
ICE2B765P2 ICE2A380P2		I _{VCC18}	-	7.1	8.3	mA	
		I _{VCC19}	-	6.7	8.0	mA	
VCC Turn-On Th VCC Turn-Off Th VCC Turn-On/Off	reshold reshold f Hysteresis	V _{CCon} V _{CCoff} V _{CCHY}	13 - 4.5	13.5 8.5 5	14 - 5.5	V V V	

Electrical Characteristics

4.4.2 Internal Voltage Reference

Parameter	Symbol	L	imit Value	es	Unit	Test Condition
		min.	typ.	max.		
Trimmed Reference Voltage	V _{REF}	6.37	6.50	6.63	V	measured at pin FB

4.4.3 Control Section

Parameter	Symbol	L	imit Val	ues	Unit	Test Condition				
		min.	typ.	max.						
Oscillator Frequency ICE2A0565/165/265/365/765I/765P2 ICE2A0565G/0565Z/180Z/280Z/380P2	f _{OSC1}	93	100	107	kHz	V _{FB} = 4V				
Oscillator Frequency ICE2B0565/165/265/365/765I/765P2	f _{OSC3}	62	67	72	kHz	V _{FB} = 4V				
Reduced Osc. Frequency ICE2A0565/165/265/365/765I/765P2 ICE2A0565G/0565Z/180Z/280Z/380P2	f _{OSC2}	-	21.5	-	kHz	V _{FB} = 1V				
Reduced Osc. Frequency ICE2B0565/165/265/365/765I/765P2	f _{OSC4}	-	20	-	kHz	V _{FB} = 1V				
Frequency Ratio <i>f</i> _{osc1} / <i>f</i> _{osc2} ICE2A0565/165/265/365/765I/765P2 ICE2A0565G/0565Z/180Z/280Z/380P2		4.5	4.65	4.9						
Frequency Ratio <i>f</i> _{osc3} / <i>f</i> _{osc4} ICE2B0565/165/265/365/765I/765P2		3.18	3.35	3.53						
Max Duty Cycle	D _{max}	0.67	0.72	0.77						
Min Duty Cycle	D _{min}	0	-	-		V _{FB} < 0.3V				
PWM-OP Gain	$A_{ m v}$	3.45	3.65	3.85						
V _{FB} Operating Range Min Level	V _{FBmin}	0.3	-	-	V					
V _{FB} Operating Range Max level	V _{FBmax}	-	-	4.6	V					
Feedback Resistance	R _{FB}	3.0	3.7	4.9	kΩ					
Soft-Start Resistance	R _{Soft-Start}	42	50	62	kΩ					

4.4.4 **Protection Unit**

Parameter	Symbol		Limit Val	ues	Unit	Test Condition
		min.	typ.	max.		
Over Load & Open Loop Detection Limit	V _{FB2}	4.65	4.8	4.95	V	$V_{\rm SoftS}$ > 5.5V
Activation Limit of Overload & Open Loop Detection	V _{SoftS1}	5.15	5.3	5.46	V	V _{FB} > 5V
Deactivation Limit of Overvoltage Detection	V _{SoftS2}	3.88	4.0	4.12	V	V _{FB} > 5V V _{CC} > 17.5V
Overvoltage Detection Limit	V _{VCC1}	16	16.5	17.2	V	V _{SoftS} < 3.8V V _{FB} > 5V
Latched Thermal Shutdown	T _{jSD}	130	140	150	°C	1)
Spike Blanking	t _{Spike}	-	5	-	μs	

¹⁾ The parameter is not subject to production test - verified by design/characterization

4.4.5 Current Limiting

Parameter	Symbol	L	imit Value	es	Unit	Test Condition
		min.	typ.	max.		
Peak Current Limitation (incl. Propagation Delay Time)	V _{csth}	0.95	1.0	1.05	V	dV_{sense} / $dt = 0.6V/\mu s$
Leading Edge Blanking	t _{LEB}	-	220	-	ns	

4.4.6 CoolMOS[™] Section

Parameter		Symbol		Limit Val	ues	Unit	Test Condition
			min.	typ.	max.		
Drain Source Brea ICE2A0565/165/2 ICE2B0565/165/2 ICE2A0565G/056	akdown Voltage 65/365/765I/765P2 65/365/765I/765P2 5Z	V _{(BR)DSS}	600 650	-	-	V V	<i>T</i> _j =25°C <i>T</i> _j =110°C
Drain Source Brea ICE2A180Z/280Z/	akdown Voltage /380P2	V _{(BR)DSS}	800 870			V V	<i>T</i> _j =25°C <i>T</i> _j =110°C
Drain Source On-Resistance	ICE2A0565	R _{DSon1}		4.7 10.0	5.5 12.5	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A165	R _{DSon2}		3 6.6	3.3 7.3	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A265	R _{DSon3}		0.9 1.9	1.08 2.28	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A365	R _{DSon4}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B0565	R _{DSon5}		4.7 10.0	5.5 12.5	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B165	R _{DSon6}		3 6.6	3.3 7.3	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B265	R _{DSon7}		0.9 1.9	1.08 2.28	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B365	R _{DSon8}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A0565G	R _{DSon9}		4.7 10.0	5.5 12.5	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A0565Z	R _{DSon10}		4.7 10.0	5.5 12.5	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A180Z	R _{DSon11}		3 6.6	3.3 7.3	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A280Z	R _{DSon12}		0.8 1.7	1.06 2.04	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A765I	R _{DSon13}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B765I	R _{DSon14}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A765P2	R _{DSon15}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2B765P2	R _{DSon16}		0.45 0.95	0.54 1.14	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C
	ICE2A380P2	R _{DSon17}		1.89 4.15	2.27 4.98	Ω Ω	<i>T</i> _j =25°C <i>T</i> _j =125°C

2. FL DISPLAY 16ST85GINK (FL81)



Grid Assignment



Pin Connection

Pin No.	4 3	4 2	4 1	4 0	3 9	3 8	3 7	3 6	3 5	3 4	3 3	3 2	3 1	3 0	2 9∽	1 5	1 4	~ 4	1	3	2	1
Connection	F 2	N P	N P	LGZD	P G N D	V H	V D D	0%0	RESET	100	C P	D A	T S A	T S B	N X			N C	1	N	N	F 1

NOTE 1) F1,F2	: Filament
2) NP	: No pin
3) NC	: No connection
4) NX	: No extend pin
5) DL	: Datum Line
6) LGND	: Logic GND pin
7) PGND	: Power GND pin
8) VH	: High Voltage Supply pin
9) VDD	: Logic Voltage Supply pin
10) CP	: Shift Register Clock
11) DA	: Serial Data Input
12) TSA,B	: Test pin
13) CS	: Chip Select Input pin
14) RESET	: Reset Input
15) OSC	: Pin for self-oscillation

----MEMO----



LEVEL DIAGRAM







COMPONENT SIDE



FOIL SIDE







SMPS PCB ASS'Y



60 DRA-F107 / DRA-F107DAB



FOIL SIDE

COMPONENT SIDE

NOTE FOR PARTS LIST

- 1. Parts for which "nsp" is indicated on this table cannot be supplied.
- 2. When ordering of part, clearly indicate "1" and "I" (i) to avoid mis-supplying.
- 3. Ordering part without stating its part number can not be supplied.
- 4. Part indicated with the mark "*" is not illustrated in the exploded view.
- 5. Not including General-purpose Carbon Film Resistor in the P.W.Board parts list. (Refer to the Schematic Diagram for those parts.)
- 6. Not including General-purpose Carbon Chip Resistor in the P.W.Board parts list. (Refer to the Schematic Diagram for those parts.)

WARNING:

Parts marked with this symbol $\begin{smallmatrix} \begin{smallmatrix} \begin{smallma$

Use ONLY replacement parts recommended by the manufacturer.

Resistors

E	c.:	RN	14	<	_2	2E	_	18	2	_	G	_	FR	
		Туре ↓	Shap and form	per- ance	Po	ower	F	Res Inco	ist- e r	All err	owab ror 	le	Others ↓	
	RD:	Carbon		2B :	1/8	W	F	:	±1%		P :	P	ulse-resista	ant type
	RC:	Composition	n	2E :	1/4	w	G	:	$\pm 2\%$		NL :	Lo	ow noise ty	ре
	RS :	Metal oxide	film	2H :	1/2	W	J	:	$\pm 5\%$		NB :	N	on-burning	type
	RW:	winding		3A :	1	w	Κ	:	$\pm 10\%$	6	FR :	Fu	use-resisto	r
	RN:	Metal film		3D :	2	w	Μ	:	±20%	6	F :	Le	ead wire fo	rming
	RK :	Metal mixtu	re	3F :	3	w								
				3H :	5	w								

* Resistance

182 1800ohm=1.8kohm \Rightarrow

Indicates number of zeros after effective number.

2-digit effective number.

 \Rightarrow 1.2ohm

1-digit effective number.

2-digit effective number, decimal point indicated by R.

: Units: ohm

1 R 2

Capacitors

Ex.:		CE	04W	<u>1H</u>	3R	2	M	BP	
		Туре	Shape and per- formance	Dielectr strength	ic Capa 1	acity	Allowable error	Others	
	CE :	Aluminum f	oil	0J: 1A:	6.3 V 10 V	F : G :	±1% ±2%	HS : BP :	High stability type Non-polar type
	CA :	Aluminium electrolytic	solid	1C: 1E:	16 V 25 V	J : K :	±5% ±10%	HR : DL :	Ripple-resistant type For change and discharge
	CS :	Tantalum el	lectrolytic	1V :	35 V	M :	±20%	HF :	For assuring high requency
	CQ: CK:	Film Ceramic		1H: 2A:	50 V 100 V	Z :	±80% - 20%	U : C :	UL part CSA part
	CC:	Ceramic		2B :	125 V	P :	+100%	W :	UL-CSA part
	CP :	Oil		2C :	160 V	C :	\pm 0.25pF	F :	Lead wire forming
	CM:	Mica		2D :	200 V	D :	\pm 0.5pF		
	CF :	Metallized		2E :	250 V	= :	Others		
	CH:	Metallized		2H: 2J:	500 V 630 V				

Capacity (electrolyte only)



· When the dielectric strength is indicated in AC,"AC" is included after the dieelectric strength value.

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PARTS LIST OF P.W.B. UNIT

 \ast Parts for which "nsp" is indicated on this table cannot be supplied.

* The parts listed below are for maintenance only, might differ from the parts used in the unit in appearances or dimensions.

Note: The symbols in the column "Remarks" indicate the following destinations. E2 : Europe model EK : U.K. model

MAIN PCB ASS'Y

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New	
SE	MICONDUCTO	RS GROUP			1			
	IC11	00D2630609002	OP AMP IC		HVINJM2068DD			
	IC12	00D9430007108	OP AMP IC		HVINJM2068MDTE1			
	IC13	00D9430059800	HEADPHONE IC		HVINJM4556AL		*	
	IC21	00D2631245009	6H VOLUME IC (10 INPUT, PLASTIC 80P QFP)		CVIM61531FPR60G			
	IC22	00D9430005702	REGULATOR IC (-8V)		HVIKA79L08AZT			
	IC23	00D9430005605	REGULATOR IC (+8V)		HVIKA78L08AZT			
	IC24	00D9430007108	OP AMP IC		HVINJM2068MDTE1			
	IC31	234010016508S	HEX INVERTER IC		HVITC74VHCT04AFT			
	IC41	00D9430007108	OP AMP IC		HVINJM2068MDTE1			
	IC61	943239007750S	HEX INVERTER IC		HVI74LVC04ADT			
	IC62	943243010810D	I.C U-COM (M3062LFGPGP Renesas)		CVIANAM1497AT			\$
	IC63	943249006970S	I.C EEPROM (4K,SO8-8P)		CVIM95040-WMN6TP			
	IC64	943239007760S	REGULATOR IC (3.3V, DPAK-5)		CVIKIA78R033F			
	IC65	00D2622977946	REGULATOR IC (3.3V SMD Type)		BVIBA33BC0FP			
	IC66	943239007240M	RESET IC 2.8V (50ms,C-MOS,SOT23-5P)		CVIS80128ALMCJANT2			
	0101 108	0000420072502						
	0301	00D9430072302						
	0307	00D9430038908						
	Q302	00D9630121606						
	0570	00D9030121000						
	0571 572	00D9030121000						
	0573 574	00D9430038908						
	0575	00D2730404901						
	0603	00D9430038009						
	0604	00D9430038009						
	0605	00D9030121000						
		00D9430030009						
	0608	00D9030121000						
	Q000	00D9430038009						
	0611	00D2030104307						
	0613	00D9030121000						
	0911	00D9430072009						
	0912	00D9430038009						
	0912	00D9030121000						
	Q013	00D9430038908						
	D101	00D2760717903	CHIP DIODE		HVD1SS355T			I
	D201,202	00D2760717903	CHIP DIODE		HVD1SS355T			
	D204,205	00D2760717903	CHIP DIODE		HVD1SS355T			
	D301,302	00D2760717903	CHIP DIODE		HVD1SS355T			
	D303,304	90M-HD302150R	ZENER DIODE		HVDMTZJ6.8BT			
	D305	00D2760717903	CHIP DIODE		HVD1SS355T			
	D351,352	00D2760717903	CHIP DIODE		HVD1SS355T			
	D371-374	00D2760717903	CHIP DIODE		HVD1SS355T			
	D570-573	00D2760717903	CHIP DIODE		HVD1SS355T			
	D601-604	00D2760717903	CHIP DIODE		HVD1SS355T			
	D607	00D2760717903	CHIP DIODE		HVD1SS355T			
	D609	00D2760717903	CHIP DIODE		HVD1SS355T	1		Í

DRA-F107 / DRA-F107DAB

Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
D610	00D9430087607	ZENER DIODE		HVDMTZJ6.2BT		
D611-612	00D2760717903	CHIP DIODE		HVD1SS355T		
ESISTORS GRO	DUP	•				
R551-554		RES , CHIP 1/4W		CRJ14CJ3R3T		
R535-538	nsp	METAL(OXIDE)FILM RES 5%		KRG1SANJ4R7RT		
R626	nsp	CHIP RES		CRJ10DJ103T		
R610	nsp	CHIP RES		CRJ10DJ103T		
R609	nsp	CHIP RES	EK	CRJ10DJ103T		
R624	nsp	CHIP RES	E2	CRJ10DJ103T		
R608	nsp	CHIP RES		CRJ10DJ103T		
C101 102						
C101,102	nsp					
C105,104	nsp			CCEATINGTOOT		
0107	nsp					
C107	nsp			CCUS1H103KC		
C108	nsp			CCEA1HH2201		
C109,110	nsp			CCEATAKS221T		
C111-112	nsp	CAP, METALLIZED FILM (6800pF/100V)		CCME2A682JXT		
C113-114	nsp	MYLAR CAP		HCQI1H682JZT		
C115,116	nsp	METALLIZED FILM CAP (100V/0.018UF, J)		CCME2A183JXT		*
C117,118	nsp	MYLAR CAP		HCQI1H392JZT		
C119,120	nsp	ELECT CAP		CCEA1HH100T		
C121	nsp	CHIP CAP		CCUS1H103KC		
C122	nsp	ELECT CAP		CCEA1HH220T		
C123,124	nsp	CHIP CAP		CCUS1H104KC		
C131	nsp	ELECT CAP		CCEA1HH1R0T		
C132	nsp	ELECT CAP		CCEA1HH4R7T		
C133,134	nsp	CHIP CAP		CCUS1H103KC		
C135,136	nsp	ELECT CAP		CCEA1HH4R7T		
C137	nsp	CHIP CAP		CCUS1H104KC		
C151,152	nsp	ELECT CAP		CCEA1HH100T		
C153,154	nsp	ELECT CAP		CCEA1CH101T		
C155,156	nsp	CERAMIC CAP		CCKT1H101KB		
C157,158	nsp	CHIP CAP		CCUS1H103KC		
C159	nsp	ELECT CAP		CCEA1HH1R0T		
C201-204	nsp	CHIP CAP		CCUS1H104KC		
C205	00D2544692901	FLECT CAP (10uE/63V REO)		CCFA1JRFO100T		
C206.207	nsp	CHIP CAP		CCUS1H104KC		
C208	nsp	CHIP CAP		CCUS1H102KC		
C209	nsp	CHIP CAP				
C210	00D2544602001			CCEA1.IREO100T		
C211 212	nen			CCUS1H103KC		
C212	1154					
C213	0002044094912	CHID CAD				
0214	nsp				_	
0215	nsp					
C210-220	nsp					
0221,222	0002044694912	CLUD CAP (10000F/25V, KFU, 12.5X20)		COLLEAL ADA LA		
0223-225	nsp					
C226	nsp			CCUS1H103KC		
C227	nsp			CCEA1CH470T		
C228	nsp			CCUS1H104KC		
C229	nsp	CHIP CAP		CCUS1H181JA		
C230,231	nsp	CHIP CAP		CCUS1H104KC		
C232-234	nsp	CHIP CAP		CCUS1H181JA		

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DRA-F107 / DRA-F107DAB

C005					
6235		nsp	CHIP CAP	CCUS1H104KC	
C236		nsp	CHIP CAP	CCUS1H103KC	
C237	C	00D2544693939	ELECT CAP(100uF/50V RFO)	CCEA1HRFO101T	
C238-	-240	nsp	CHIP CAP	CCUS1H101JA	
C241		00D2544693900	FLECT CAP (FLNA, REO, 50V/22UE)	CCEA1HREO220T	
C242		nsp		CCUS1H103KC	
C243	0	0002544693926	ELECT CAP $(47\mu E/50)/(REO)$	CCEA1HREO470T	
C244	Ì	nen			
C245	0	0002544693900	ELECT CAP (ELNA REO 50\//22LIE)	CCEA1HRE0220T	
C246	249	nen			
C250	245	nsp			
C251		nsp			
C257	252	nsp			
0252,	,200	nsp			
0254		nsp			
0200		nsp			*
0256	5	9431340069405			
0257		nsp			+
C258	ç	9431340069408	ELECT CAP(4/uF/50V ROA)	CCEA1HROA4701	Ŷ
C259		nsp		CCUS1H104KC	
C261,	,262	nsp	CERAMIC CAP (100PF/50V)	CCBS1H101KB1	
C263,	,264	nsp		CCUS1H103KC	
C265,	,266 (00D2544693900	ELECT CAP (ELNA, RFO, 50V/22UF)	CCEA1HRFO220T	
C267,	,268	nsp	METALLIZED FILM CAP (1000pF APSV)	CCMP2A102JN09T	*
C269		nsp	ELECT CAP	CCEA1HH1R0T	
C271,	,272	nsp	CHIP CAP	CCUS1H473KC	
C273,	,274	nsp	ELECT CAP	CCEA1HH4R7T	
C275-	-284	nsp	ELECT CAP	CCEA1HH100T	
C286		nsp	CHIP CAP	CCUS1H181JA	
C297,	,298	nsp	CHIP CAP	CCUS1H104KC	
C301,	,302	nsp	CHIP CAP	CCUS1H470JA	
C303		nsp	CHIP CAP	CCUS1H102KC	
C305		nsp	CHIP CAP	CCUS1H104KC	
C351,	,352	nsp	CHIP CAP	CCUS1H181JA	
C353		nsp	CHIP CAP	CCUS1H104KC	
C570-	-572	nsp	CHIP CAP	CCUS1H102KC	
C573,	,574	nsp	EIECT CAP (220uF/25V, RFO)	CCEA1ERFO221T	
C575,	,576 9	943139001280S	METALLIZED FILM CAP	CCME2A103JXT	
C577,	,578	nsp	CHIP CAP	CCUS1H104KC	
C601		nsp	CHIP CAP	CCUS1H101JA	
C602,	,603	nsp	CHIP CAP	CCUS1H104KC	
C604		nsp	ELECT CAP	CCEA1AH471T	
C605,	,606	nsp	CHIP CAP	CCUS1H104KC	
C607	0	00D2544693939	ELECT CAP(100uF/50V RFO)	CCEA1HRFO101T	
C608		nsp	ELECT CAP	CCEA1AH471T	
C609		nsp	CHIP CAP	CCUS1H104KC	
C610		nsp	ELECT CAP	CCEA1CH101T	
C611,	612	nsp	CHIP CAP	CCUS1H104KC	
C613		nsp	ELECT CAP	CCEA1CH101T	
C614		nsp	ELECT CAP	CCEA1HH1R0T	
C617		nsp	CHIP CAP (15PF/50V)	CCUS1H150JA	
C618		nsp	CHIP CAP	CCUS1H270JA	
C619		nsp	CHIP CAP	CCUS1H103KC	
C620-	-623	nsp	CHIP CAP	CCUS1H104KC	
C625	,626	nsp	ELECT CAP	CCEA1HH100T	
C636-	-639	nsp	CHIP CAP (2012 SIZE)	CCUC2A103KC	
C642	,644	nsp	CHIP CAP	CCUS1H104KC	

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
	C640	nsp	CHIP CAP		CCEA1CH470T		
ΟΤΙ	HERS PARTS	GROUP					
	BD81	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		
	BD02-04	nsp	CHIP FERRITE BEAD(220ohm, 2012)		CLZ9R006Z		
	BD82-85	nsp	CHIP FERRITE BEAD(220ohm, 2012)		CLZ9R006Z		
	BN61	nsp	7P WIRE ASS'Y(120mm, 2.0mm)		CWB1C90712047		
	BR21-24	nsp	EARTH PLATE		HJT1A025		
	CN82	nsp	LOCKING TYPE , STRAIGHT WAFER , 2MM		CJP07GI236ZW		
	CN96	nsp	LOCKING TYPE , STRAIGHT WAFER , 2mm		CJP05GI236ZW		
	JK11	nsp	JACK, RCA(2P, RCA-215-13, W/R, NO PLATE)		CJJ4N089Z		
	JK12	nsp	BOARD JACK		CJJ4M046Z		
	JK21,22	nsp	BOARD JACK		CJJ4P048Z		
	JK31,32	nsp	STEREO JACK		CJJ2D008Z		
	JK51	943643007770S	4P SPK TERMINAL (RD/BK, RD/BK, 94V-O)		CJJ5P031Z		*
	L101,102	00D9430193601	TOROIDAL COIL		CLU9S004Z		*
	RL51	00D9430060608	RELAY		HSL4A004ZU		
	WC11	nsp	FEMALE HEADER (14P,2.54mm) , STRAIGHT TYPE		CJP14GA221ZB		
	WC51	nsp	FEMALE HEADER (6P,2.54mm) , STRAIGHT TYPE		CJP06GA221ZB		
	WC52	nsp	FEMALE HEADER (12P,2.54mm) , STRAIGHT TYPE		CJP12GA221ZB		
	WC61	nsp	FEMALE HEADER (08P,2.54mm) , STRAIGHT TYPE		CJP08GA221ZB		
	WF31	nsp	WAFER , CARD CABLE		CJP15GA115ZY		
	WN21	nsp	WAFER , CARD CABLE		CJP13GA115ZY		
	WN31	nsp	WAFER , CARD CABLE		CJP15GA115ZY		
	WN32	, nsp	WAFER		CJP09GA117ZY		
	WN81	nsp	WAFER		CJP21GA117ZY		
	WP11	nsp	PIN HEADER(14PIN, 2.54mm, ANGLE)		CJP14GB142ZB		
	X202	943141007780S	X-TAL , HC-49/S (14.7456MHz 18pF)		COX14745E180C		*

FRONT PCB ASS'Y

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
SEN		PS GPOLIP					
361		943239007760S		I E K			l
		042230007000					
	1072	0002631100018		EIX			
	1091	0002031100010					
	0701	0000430004305	тр			'	<u>├</u> ───
	0805 806	0003430004305		EIX			
	0003,000 0007 808	0000430154200					
	000 810	0009430134200					
	0001	0009030121000					
	0002	0009430072600				'	
	Q903	0009430072009					
	Qain	0009430004303	IR				
	5700	0000400400500			OVD4N4002CT		
	D702	0009430162502		EK			
<u> </u>	D801	00D9430106203		 	HVDSPR39IVIVV3	 '	
	D802-805	00D2760717903			HVD1SS3551		
	D902	00D9430182502	RECT DIODE		CVD1N4003S1		
	D905-911	00D9430041902	SCHOTTKY DIODE		HVD1N5819T		
	D921-923	00D9430182502	RECT DIODE		CVD1N4003ST		1
	D924	00D9430086404	DIODE	ļ	HVD1SS133MT	' ا	
	D938	00D9430086404	DIODE		HVD1SS133MT		1
		1					1
	<u> </u>	ļ		<u> </u>			
RES	SISTORS GRO	UP			- -		
	VR81	943667007540S	ENCODER VOLUME		CSR2A052Z		*
	VR82	943667007550S	ENCODER, FUNCTION (16MM, 24PULSES)		CSR2A051Z		*
	!	1					
CAF	PACITORS GR	OUP					
	C701,702	nsp	ELECT CAP	EK	CCEA1HKS4R7T	['	Ī
	C703	nsp	CERAMIC CAP	EK	CCBS1H104ZFT		
	C703	nsp	COPPER WIRE		C3A206		
	C704	nsp	CERAMIC CAP	EK	CCBS1H104ZFT		
	C704	nsp	COPPER WIRE		C3A206		
	C705	nsp	ELECT CAP	EK	CCEA0JH471T		
	C706	nsp	ELECT CAP	EK	CCEA0JKS470T		
	C707,708	nsp	CERAMIC CAP	EK	CCBS1H103ZFT		
	C710	nsp	ELECT CAP	ЕК	CCEA0JKS470T		
	C711	nsp	CERAMIC CAP	EK	CCBS1H104ZFT		
	C713,714	nsp	CERAMIC CAP	EK	CCBS1H104ZFT		1
-	C715	nsp		FK	CCBS1H104ZFT		
	C715	nsp		F2	C3A206		
	C716	nsn		FK	CCFA1AH221T		
	C801	nen			CCEA1CKS101T		
	0001	nen			CODE4U4027ET		
		пар				<u> </u> '	
	0003	пър					
		nsp					
	0805-807	nsp	CERAMIC CAP (TOUPF/SUV)				
	C808-810	nsp			CCBS1H104ZF1		
	C811	nsp			CCBS1H1032F1	 '	<u> </u>
	C813,814	nsp	CERAMIC CAP		CCBS1H103ZFT		
	C815,816	nsp	CERAMIC CAP (1000PF/50V)		CCBS1H102KBT		
	C817	nsp	CERAMIC CAP		CCBS1H103ZFT		
	C819,820	nsp	ELECT CAP		CCEA1HKS4R7T		
	C821,822	nsp	CERAMIC CAP (470PF/50V)		CCBS1H471KBT		
	C823	nsp	CERAMIC CAP	Γ	CCBS1H104ZFT	['	Ē.
	C824.825	943139001280S	METALLIZED FILM CAP		CCME2A103JXT		1

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
	C826,827	nsp	CHIP CAP		CCUS1H104KC		
1	C830	nsp	CERAMIC CAP (1000PF/50V)		CCBS1H102KBT		
1	C831	nsp	CERAMIC CAP		CCBS1H104ZFT		
	C832	nsp	ELECT CAP		CCEA1HKS1R0T		
1	C833	nsp	CERAMIC CAP (1000PF/50V)		CCBS1H102KBT		
1	C834	nsp	ELECT CAP		CCEA1CKS101T		
1	C835,836	nsp	CERAMIC CAP		CCBS1H104ZFT		
	C843,844	nsp	CERAMIC CAP		CCBS1H103ZFT		
	C846	nsp	CHIP CAP		CCUS1H104KC		
	C901	00D2544693939	ELECT CAP(100uF/50V RFO)		CCEA1HRFO101T		
	C902,903	nsp	CERAMIC CAP		CCBS1H104ZFT		
	C904	00D2544693939	ELECT CAP(100uF/50V RFO)		CCEA1HRFO101T		
	C905	nsp	CERAMIC CAP		CCBS1H103ZFT		
	C907-911	nsp	CERAMIC CAP		CCBS1H103ZFT		
	C912	nsp	ELECT CAP		CCEA1EH222E		
	C913-915	nsp	CERAMIC CAP		CCBS1H103ZFT		
1	C916,917	nsp	CERAMIC CAP		CCBS1H104ZFT		
1	C918	nsp	ELECT CAP		CCEA1EH222E		
\triangle	C922	00D9430024408	CERAMIC CAP (X1/Y2/SC)		KCKDKS472ME		
\triangle	C952	90M-OF100550R	CAP , X2		CCQF2E104KZC		
1							
ΟΤΙ		GROUP		1			
	BN82	nsp	7P SHIELD WIRE ASS'Y(180mm, 2.0mm)		CWB1B90718047001		
	BN83	nsp	5P WIRE ASS'Y(100mm, 2.0mm)		CWB1C90510047		
1							
1	BR71		BRACKET, PCB		CMD1A629		
 	BR72		BRACKET, PCB		CMD1A569		
	BR81	nsp			HJT1A025		
1	BR82,83	nsp	FLT BRACKET		CMD1A468		
1							
1	CN71	nsp	2.54mm 30PIN WAFER	ĔΚ	CJP30GA221ZB		
	CN93	nsp	WAFER		CJP02GA89ZY		
1		000000000000000000000000000000000000000					
A		00D3938086009	V.F.D, DCD-510AE (16S185GINK)		UFL165185GINK		
<u>/\</u>	F801	nsp			KJUFU5S		<u> </u>
<u> </u>	F801	00D9430207208	FUSE 1.25AL/25UV		KBAZU1250TLEY		î
	JK81.82	00D9430105204	HEADPHONE JACK (SILVER)		HJJ2D003Y		
1	JK91	00D9430199206	AC OUTLET (EUR/1P)		KJJ7A022Z		*
	JK93	00D2033905015	AC INLET (250V/2.5A PCB MOUNT TYPF)		CJJ8A012Z		
1			(<u></u>)				
1	L803	nsp	CORE BEAD		KLZ9H001Z		
	L801,802	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		
	L903	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		
1							
1	RC81	00D9430194706	REMOCON SENSOR		CRVKSM603TH2E		
	RL91	00D9430194900	POWER RELAY		CSL1E002ZE		
1							
1	S801-805	00D9430004402	TACT SW		CST1A012ZT		
1	S809	00D9430004402	TACT SW		CST1A012ZT		
<u>^</u>	T902	9431010070100			CI T510157E		*
	1302	545101007810D			GETOIOTOZE		
	WF81	nsp	WAFER		CJP21GA117ZY		
	WP82	nsp	PIN HEADER (08P, 2.54mm) , ANGLE TYPE		CJP08GB142ZB		

SMPS PCB ASS'Y

	Ref. No.	Part No.	Part Name	Remarks		Q'tv	New
SEN						- j	
	IC91	9432310076505	VOL-REGULATOR IC (15V TO-220IS-4)		CVIKIA7815AP		*
	1001	9432350032005			CV/IICE2B265		*
	1032	9432350032105					*
	1093	9432350032105					*
	1094	9432310076605	REGULATORIC (24V, TO-92L)				
	1096	90M-HC300770R			HVIKIA431BAI		
	IC97	00D9430206908	REGULATOR IC (12V OUTPUT LOW DROP)		HVIKIA78R12PI		
	IC98	00D9430183909	REGULATOR IC		HVIKIA7912PI		
	IC99	90M-HC300770R	REGULATOR IC		HVIKIA431BAT		
	PC91,92	00D9430038601	PHOTO COUPLER		HVIPC17L1CB		
	0000.004	0400400070000					
	Q933,934	943219007680S	I.R (TO-126, EPITAXIAL PLANAR NPN)		CVIKID1691Y		
	Q903	943229007670S	F.E.T , SPW20N60C3 (N-CH, P-TO247, POWER,INFINEO		CVTSPW20N60C3		*
	Q931	00D9430107804	T.R		HVTKRC102MT		
	Q935	943213003350S	SWITCHING TR		CVTKTN2222A		*
	D902	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D904-908	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D911	00D9430182609	DIODE		HVD1SS133MT		
	D912	90M-HD302310R	ZENER DIODE		HVDMTZJ27BT		
	D913	00D9430195909	ZENER DIODE		HVDMTZJ16BT		
	D914 915	00D9430087102			HVDMT7.120BT		
	D920-924	00D9430182609			HVD1SS133MT		
	D020 024						*
	D931	90101-11D201930K					*
	D933	00D9430040709					
	D935	00D9430087500					
	D936	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D938	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D939	00D9430182609	DIODE		HVD1SS133MT		
	D940,941	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D944,945	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D946	00D9430182609	DIODE		HVD1SS133MT		
	D950	943202007690S	ZENER DIODE (ROHM,18V)		HVDMTZJ18BT		
	D951	943203003140S	SCHOTTKY DIODE (20A, 200V)		CVDFCH20A20		*
\triangle	DB91	943203003170S	BRIDGE DIODE		HVDGBJ606		*
RES	SISTORS GRO		I	I		<u>і</u> Т	і Т
	R910	nsp	WIRE WOUND RES (1W/0.5ohm)		CRW1PJR50V		
	R911	nsp	METAL OXIDE FILM RES		KRG2SANJ683H		
	R920,921	nsp	WIRE WOUND RES		CRW1PJR15V		
	R928	nsp	METAL OXIDE FILM RES		KRG2SANJ683H		
	R968	nsp	METAL OXIDE FILM RES		CRG1ANJ100R		
	R970	nsp	METAL OXIDE FILM RES (2W, 2.2K)		CRG2SANJ222RT		
	R991	nsp	METAL FILM RES (1/2W , 1M OHM)		KROS1TJ105V		
	R995	nsp	METAL OXIDE FILM RES (2W, 75ohm)		CRG2SANJ750RT		
	PACITORS GR	OUP					
., 11	C901	9431340077905	ELECT CAP (K3J. 450V/390UF. 105. 35X50)		CCET450VK3J391AK		*
	C902	nen			C3A206		<u> </u>
	C002	00MOE15002544			CCMDA 222 INIOOT		
	0004	0010101715223541					
	0904	nsp					
	10905	nsp	IMONO CAP (50V.102)		ICCUMT1H102KB	1	1

SMPS PCB ASS'Y

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
SEI		RS GROUP					_
		9432310076505	VOL-REGULATOR IC (15V TO-220IS-4)		CVIKIA7815AP		*
	1001	9432350032005			CVIICE2B265		*
	1002	9432350032105					*
	1095	9432310076605			CV/II 78I 24AB		*
	1094	9432310070003					
	1090	0000420206008					
	1097	00D9430200908					
	1098	00D9430183909					
	1099	90M-HC300770R					
	PC91,92	00D9430038601	PHOTO COUPLER		HVIPC17L1CB		
	Q933,934	943219007680S	T.R (TO-126, EPITAXIAL PLANAR NPN)		CVTKTD1691Y		
	Q903	943229007670S	F.E.T , SPW20N60C3 (N-CH, P-TO247, POWER,INFINEO		CVTSPW20N60C3		*
	Q931	00D9430107804	T.R		HVTKRC102MT		
	Q935	943213003350S	SWITCHING TR		CVTKTN2222A		*
1	D902	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D904-908	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D911	00D9430182609	DIODE		HVD1SS133MT		
	D912	90M-HD302310R	ZENER DIODE		HVDMTZJ27BT		
	D913	00D9430195909	ZENER DIODE		HVDMTZJ16BT		
	D914,915	00D9430087102	ZENER DIODE		HVDMTZJ20BT		
	D920-924	00D9430182609	DIODE		HVD1SS133MT		
	D931	90M-HD201950R	SCHOTTKY DIODE (60V/1A)		HVD11EQ06T		*
	D933	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D935	00D9430087500	ZENER DIODE		HVDMTZJ5.6BT		
	D936	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D938	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D939	00D9430182609	DIODE		HVD1SS133MT		
	D940.941	00D9430040709	SCHOTTKY DIODE		HVDUF4007T		*
	D944.945	00D9430040806	SCHOTTKY DIODE		HVDUF4004T		*
	D946	00D9430182609	DIODE		HVD1SS133MT		
	D950	943202007690S			HVDMTZ.I18BT		
	D951	943203003140S					*
Â	DB01	9432030031708					*
213	0031	3432030031703					
RE	SISTORS GRO	UP		[1	
Í	R910	nsp	WIRE WOUND RES (1W/0.5ohm)		CRW1PJR50V		
I	R911	nsp	METAL OXIDE FILM RES		KRG2SANJ683H		
Í	R920,921	nsp	WIRE WOUND RES		CRW1PJR15V		
	R928	nsp	METAL OXIDE FILM RES		KRG2SANJ683H		
1	R968	nsp	METAL OXIDE FILM RES		CRG1ANJ100R		
1	R970	nsp	METAL OXIDE FILM RES (2W, 2.2K)		CRG2SANJ222RT		
	R991	nsp	METAL FILM RES (1/2W , 1M OHM)		KROS1TJ105V		
	R995	nsp	METAL OXIDE FILM RES (2W, 75ohm)		CRG2SANJ750RT		
CAI	I PACITORS GR	OUP	1	<u> </u>	1	I	
	C901	943134007790S	ELECT CAP (K3J, 450V/390UF, 105, 35X50)		CCET450VK3J391AK		*
	C902	nsp	COPPER WIRE		C3A206		
1	C903	nsp	MYLAR CAP (0.022uF/100V)		CCQI2A223JZT		
1	C904	nsp	COPPER WIRE		C3A206		
	C905	nsp	MONO CAP (50V.102)		CCUMT1H102KB		

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	C917	nsp	CERAMIC CAP	CCKT3A222KBL	
	C918,919	nsp	MONO CAP	CCUMT1H104KB	
	C921,926	nsp	MONO CAP	CCUMT1H104KB	
	C922	943134003030S	ELECT CAP (KRM, 100V/1UF, 105C, 5X11)	CCEA2AH1R0TS	*
	C923,924	nsp	MONO CAP	CCUMT1H104KB	
	C925	nsp	CERAMIC CAP	CCKT3A102KBL	
	C931	nsp	ELECT CAP (1000uF/10V, 10X16, KLH)	CCEA1AKLH102EKS	*
	C932	nsp	ELECT CAP	CCEA1HH1R0TS	
	C933	nsp	ELECT CAP (10V/2200UF, 105C, 10X20)	CCEA1AH222ES	
	C935	nsp	ELECT CAP	CCEA1JH470TS	
	C935	nsp	ELECT CAP (47uF/63V, 8X12, KLH)	CCEA1JKLH470TKS	
	C936	00D2544692930	ELECT CAP(47uF/63V RFO)		
	C940	nsp	ELECT CAP (100uF/16V, 6.3X11, KLH)	CCEA1CKLH101TKS	
	C948	nsp	ELECT CAP (100uF/25V, 6.3X11, KLH)	CCEA1EKLH101TKS	
	C949	943134008030S	ELECT CAP(56uF/25V RJH)		*
	C950	943134006960S	ELECT CAP (470uF/35V RJH)		*
	C951	943134008040S	ELECT CAP(220uF/25V RJH)		*
	C960	nsp	ELECT CAP	CCEA1HH1R0TS	
	C962	nsp	CAP , CHIP(3216 SIZE)	CCUP2A104KC	
	C965	nsp	CERAMIC CAP	CCKT3A102KBL	
	C967	nsp	ELECT CAP (2200uF/35V, 16X31.5, KLH)	CCEA1VKLH222EKS	
	C968	nsp	ELECT CAP	CCEA1HH102ES	
	C969-972	nsp	MONO CAP	CCUMT1H104KB	
	C974,975	nsp	COPPER WIRE	C3A206	
	C976-980	nsp	MONO CAP	CCUMT1H104KB	
	C985	00D2544692930	ELECT CAP(47uF/63V RFO)		
	C987,988	nsp	MONO CAP	CCUMT1H104KB	
OTH	IERS PARTS	GROUP	1		
	BN91	nsp	7P WIRE ASS'Y(220mm, 2.0mm)	CWB1E90722058	
	CN90	nsp	WAFER	KJP02KA060ZY	
	CN91	nsp	LOCKING TYPE , STRAIGHT WAFER, 2.5MM	CJP07GI237ZW	
	CN92	nsp	LOCKING TYPE , STRAIGHT WAFER , 2MM	CJP07GI236ZW	
	CN93	nsp	LOCKING TYPE , STRAIGHT WAFER , 2.5MM	CJP05GI237ZW	
	CX91	nsp	POLYPROPYLENE FILM CAP	CCQF2E224KZE	
\triangle	CX92	nsp	POLYPROPYLENE FILM CAP	HCQF2E104KZE	
	CY91,92	nsp	CERAMIC CAP (400V Y-CAP)	CCKDHS102ME	
\triangle	CY94	nsp	CERAMIC CAP (400V Y-CAP)	CCKDHS222ME	
Í					
	FH91,92	nsp	FUSE HOLDER	KJCFC5S	
\triangle	F901	943652008050S	FUSE (215 Series, 250V,3.15A)	KBA2C3150TLHEY	*

Part Name

Remarks

CCUMT1H104KB

CCEA1HH220TS

CCUMT2A472KC

CCUMT1H474KC

CCKT3A222KBL

CCUMT1H102KB

CCUMT2A222KC

CCUMT1H101KC

CCKT3A221KB

CCEA1HH220TS

CCUMT1H471KC

Q'ty

New

Ref. No.

C906

C907

C908

C909

C910

C911

C912

C913

C914

C915

C916

Part No.

nsp

MONO CAP

ELECT CAP

CERAMIC CAP

ELECT CAP

MONO CAP (4700pF/100V)

MONO CAP (2200pF/100V)

CERAMIC CAP (220PF/1KV)

MLCC CAP (100PF/50V)

MONO CAP (470PF/50V)

MONO CAP (0.47uF/50V)

MONO CAP (50V.102)

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
\triangle	LF91,92	943111007730S	LINE FILTER(22mH, RING-615)		CLZ9Z113Z		
	L921	943111003310S	CHOKE COIL (20uH)		CLZ9Z074Z		*
	L922	943111007720S	CHOKE COIL (220uH)		CLZ9Z112Z		*
	L928	943111003330S	CHOKE COIL (7UH)		CLZ9Z090Z		*
	TF91	943102007610D	SWITCHING TRANS EE1312 V-TYPE		CLT9Z053ZE		*
	TF92	943102007620D	SWITCHING TRANS EE2525W V-TPYE		CLT9Z054ZE		*
	TF93	943102007630D	SWITCHING TRANS EER4042 H-TYPE		CLT9Z055ZE		*
	TH91	00D9430035206	THERMISTOR NTC (10MM PITCH)		KRT5D15MSFC		
	TS91	943252007740S	THERMAL PROTECTOR (100'C, 70mm)		CRTST22100070W		*
\triangle	VT91	943251003480S	VARISTOR		CRVSVC471D14A		
	BD90-99	nsp	CHIP FERRITE BEAD(60ohm, 4516)	CLZ9Z014Z			*

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AMP	PCB	ASS'Y
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	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New		
	IC51,52	00MHC10102090	OP AMP IC		HVINJM2068MDT				
	IC53	943231007700S	REGULATOR IC (12V, DPAK-5)		CVIKIA78R12F				
	IC54	943235007710S	CLASS-D DIGITAL AMP IC (300W, DKD-44P)		CVITAS5630DKD				
	D501-506	00D2760717903	CHIP DIODE		HVD1SS355T				
	D508-510	00D2760717903	CHIP DIODE		HVD1SS355T				
	D515-522	00D2760717903	CHIP DIODE		HVD1SS355T				
CA	PACITORS GR	OUP				1			
	C501,502	nsp	ELECT CAP		CCEA1HH100T				
	C503-506	nsp	CHIP CAP		CCUS1H101JA				
	C511	nsp	CHIP CAP		CCUS1H104KC				
	C512	00D9430185402	ELECT CAP (ELNA RFO 100uF/25V)		CCEA1ERFO101T				
	C513	nsp	CHIP CAP		CCUS1H104KC				
	C515	00D2544693939	ELEC CAP ELNA RFO SERIES 100uF/50V		CCEA1HRFO101T				
	C516	nsp	CHIP CAP		CCUS1H104KC				
1	C518-521	00D2544693900	ELECT CAP (ELNA, RFO, 50V/22UF)		CCEA1HRFO220T				
1	C522	nsp	CHIP CAP		CCUS1H331JA				
	C523	nsp	CHIP CAP (25V/4.7uF, 2125 SIZE)		CCUC1E475KC				
	C524	nsp	CHIP CAP		CCUS1H472KC				
	C525	nsp	CHIP CAP (25V/4.7uF, 2125 SIZE)		CCUC1E475KC				
	C526,527	nsp	CHIP CAP		CCUS1H104KC				
	C528	nsp	CHIP CAP		CCUS1H102KC				
	C529	00D2544694912	EIECT CAP (220uF/25V, RFO)		CCEA1ERFO221T				
	C530	nsp	CHIP CAP		CCUS1H102KC				
	C531	nsp	CHIP CAP		CCUS1H104KC				
	C532	943134007870S	ELECT CAP (1800uF/35V, ELNA, RJF, 16X25)		CCEA1VRJF182E		*		
	C533	nsp	CHIP CAP		CCUS1H102KC				
	C534	nsp	CHIP CAP		CCUS1H103KC				
	C535	nsp	CHIP CAP		CCUS1H104KC				
	C536	nsp	CHIP CAP (50V/4.7uF, 3216 SIZE)		CCUP1H475KC				
	C537	nsp	CHIP CAP		CCUS1H102KC				
	C538	nsp	CHIP CAP		CCUS1H333KC				
	C539	nsp	CHIP CAP (50V/4.7uF, 3216 SIZE)		CCUP1H475KC				
	C540	nsp	CHIP CAP		CCUS1H333KC				
	C541	nsp	CHIP CAP (50V/4.7uF, 3216 SIZE)		CCUP1H475KC				
1	C542	nsp	CHIP CAP		CCUS1H333KC				
1	C543,544	nsp	CHIP CAP (50V/4.7uF, 3216 SIZE)		CCUP1H475KC				
1	C545	nsp	CHIP CAP		CCUS1H333KC				
	C546	nsp	CHIP CAP (50V/4.7uF, 3216 SIZE)		CCUP1H475KC				
1	C547	nsp	CHIP CAP		CCUS1H102KC				
1	C548	nsp	CHIP CAP		CCUS1H104KC				
1	C549	nsp	CHIP CAP		CCUS1H103KC				
1	C550	nsp	CHIP CAP		CCUS1H102KC				
[C551	943134007870S	ELECT CAP (1800uF/35V, ELNA, RJF, 16X25)		CCEA1VRJF182E		*		
	C554	nsp	POLYESTER CAP (100V/0.47uF, Panasonic ECQV Type)		CCME2A474JO14		*		
	C556	nsp	POLYESTER CAP (100V/0.47uF, Panasonic ECQV Type)		CCME2A474JO14		*		
1	C558-561	nsp	CHIP CAP (2012 SIZE)		CCUC2A103KC				
	C562	nsp	POLYESTER CAP (100V/0.47uF, Panasonic ECQV Type)		CCME2A474JO14		*		
	C564	nsp	POLYESTER CAP (100V/0.47uF, Panasonic ECQV Type)		CCME2A474JO14		*		
	C566-569	nsp	CHIP CAP		CCUS1H102KC				
	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New		
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	C580	nsp	CHIP CAP		CCUS1H104KC				
	C581	00D2544693900	ELECT CAP (ELNA, RFO, 50V/22UF)		CCEA1HRFO220T				
	C584	00D2544694912	EIECT CAP (220uF/25V, RFO)		CCEA1ERFO221T				
	C583	nsp	CHIP CAP		CCUS1H101JA				
	C585	nsp	CHIP CAP		CCUS1H101JA				
	C586	00D2544694912	EIECT CAP (220uF/25V, RFO)		CCEA1ERFO221T				
	C587	nsp	CHIP CAP		CCUS1H102KC				
	C588	nsp	CHIP CAP		CCUS1H103KC				
	C589	nsp	CHIP CAP		CCUS1H104KC				
	C590,591	943134006960S	ELECT CAP (1000uF/50V, ELNA, RFO)				*		
	C595	nsp	CHIP CAP		CCUS1H104KC				
	C596	nsp	CHIP CAP		CCUS1H102KC				
	C631-634	nsp	CHIP CAP (330pF/100V,2012 SIZE)		CCUC2A331JA				
	C635	nsp	CHIP CAP		CCUS1H104KC				
	C651-655	nsp	CAP CAP 0.1UF/50V/2012		CCUC1H104KC				
OTH	HERS PARTS	GROUP							
	BD51	nsp	CHIP FERRITE BEAD(220ohm, 2012)		CLZ9R006Z				
	BD52-57	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		*		
	BD59	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		*		
	BD60	nsp	CHIP FERRITE BEAD(60ohm, 4516)		CLZ9Z014Z		*		
	CN91	nsp	LOCKING TYPE , STRAIGHT WAFER, 2.5MM		CJP07GI237ZW				
	L501-504	00MLC11034420	POWER INDUCTOR COIL		CLZ9Z111Z				
	WP51	nsp	PIN HEADER(6P, 2.54mm)		CJP06GB142ZB				
	WP52	nsp	PIN HEADER(12PIN, 2.54mm, ANGLE)		CJP12GB142ZB				

WIRING DIAGRAM



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PARTS LIST OF EXPLODED VIEW

 \ast Parts for which "nsp" is indicated on this table cannot be supplied.

* P.W.B. ASS'Y for which "nsp" is indicated on this table cannot be supplied. When repairing the P.W.B. ASS'Y, check the board parts table and order replacement parts.

st The parts listed below are for maintenance only, might differ from the parts used in the unit in appearances or dimensions.

Note: The symbols in the column "Remarks" indicate the following destinations.

E2 : Europe model	EK : U.K. model
BK : Black model	SP : Premium Silver model

Ref. No.	Part No.	Part Name	Remarks		Q'ty	New
— C2A	nsp	FRONT PCB ASS'Y	E2	CIP12218B	1	*
— C2A	nsp	FRONT PCB ASS'Y	EK	CIP12218C	1	*
C2	-	FRONT PCB				
Ц— C6	-	POWER PCB				
L C9	-	DAB PCB	EK			
C8A	nsp	MAIN PCB ASS'Y	E2	CIP12217B	1	*
— C8A	nsp	MAIN PCB ASS'Y	EK	CIP12217C	1	*
C4	-	SUB PCB				
— C8	-	MAIN PCB				
— C11	-	PHONO PCB				
L C13	-	UPDATE PCB				
C3	nsp	SMPS PCB ASS'Y		CIP12227B	1	*
C7	nsp	AMP PCB ASS'Y		CIP12242B	1	*
P1	943416007600D	WINDOW		CGU1A440Y	1	*
P2	943443006530D	INNER PANEL	BK	CGW1A484B28	1	*
P2	943443006540D	INNER PANEL	SP	CGW1A484RGG45	1	*
P3	943481000370D	LENS		CGL1A230A14	1	
P4	943412006550D	5P KNOB	ВК	CBT1A1115MBC57	1	*
P4	943412007590D	5P KNOB	SP	CBT1A11157MBC22	1	*
P5	00D9430094506	FOOT		CKL1A189	4	
P6	943471006570D	CUSHION		CHG1A285	4	
M1	00D1120884228	KNOB(F) ASSY	ВК	CGK00D1120884228D	1	*
M1	00D1120884215	KNOB(F) ASSY	SP	CGK00D1120884215D	1	
M2	00D1120980119	VOLUME KNOB ASSY	BK	CGK00D1120980119D	1	*
M2	00D1120980106	VOLUME KNOB ASSY	SP	CGK00D1120980106D	1	
M3	943402006580D	FRONT PANEL (AL)	BK E2	CKM1A217ZC45	1	*
M3	943402006590D	FRONT PANEL (AL)	SP E2	CKM1A217ZC62	1	*
M3	943402007920D	FRONT PANEL (AL)	BK EK	CKM1A217YC45	1	*
M3	943402007930D	FRONT PANEL (AL)	SP EK	CKM1A217YC62	1	*
M4	943412006440D	POWER KNOB ASSY	ВК	CBY1A049ZA	1	*
M4	943412006450D	POWER KNOB ASSY	SP	CBY1A049YA	1	*
M5	nsp	FIP BRACKET		CMD1A468	2	*
M6	nsp	EARTH PLATE		CMC1A371	1	*
M7	943403006630D	TOP CABINET	ВК	CKC1A198B49	1	*
M7	943403006640D	TOP CABINET	SP	CKC1A198G60	1	*
M8	nsp	SCREW COVER		CMD1A495	1	*
M9	nsp	MAIN CHASSIS		CUA1A300	1	*
M10	nsp	PC COVER		CMX1A268	1	*
M11	nsp	HEAT SINK		CMY1A331	1	*
M12	nsp	PCB BRACKET		CMD1A629	2	
M13	nsp	PCB BRACKET		CMD1A569	2	
M14	943406007940D	REAR PANEL	EK	CKF1A406Z	1	*
M14	943406006650D	REAR PANEL	E2	CKF2A406Z	1	*
M15	nsp	GROUND TERMINAL		KMA1A006	1	

	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New	
	M16	nsp	WASHER	EK	CNW1A052	1		Ź
	M17	nsp	DAB NUT	EK	CNE1A009	1		
	M18	nsp	PC INSULATOR		CMX1A274	1	*	
	M19	nsp	BRACKET SHIELD		CMD1A723	1	*	
	C1	943172007420D	FIP		CFL16ST85GINK	1		
	C10	943183007950S	DAB	EK	CNVF2025-1V328A	1		
	C12	00D9430055202	TUNER PACK		CNVMV114MA1-19(E2/ EK)	1		
\triangle	C14	943611007960S	AC CORD	E2	CJAZB108ZV(E2)	1		
\triangle	C14	943611000210S	AC CORD	EK	CJA2E106ZV(EK)	1		
SCF	REWS							
	S1	nsp	SCREW	ВК	CTBD3+8JFZR	9		
	S1	nsp	SCREW	SP	CTBD3+8JFN	9		
	S2	nsp	SCREW		CTB3+6FFZR	10		
	S3	nsp	SCREW		CTB3+8JFZR	11		
	S4	nsp	SCREW		CTS3+8JR	3		
	S5	nsp	SCREW		CTB3+10JR	9		
	S6	nsp	SCREW		CTW3+8JR	6		
	S7	nsp	SCREW	SP	CTB3+10JFZR	10		
	S7	nsp	SCREW	ВК	CTB3+10JFZR	9		
	S8	nsp	SCREW	ВК	CTWD4+6FFZR	2		
	S8	nsp	SCREW	SP	CTWD4+6FFN	2		
	S9	nsp	SCREW		CTB3+6JR	2		

PACKING VIEW



PARTS LIST OF PACKING & ACCESSORIES

 $\ast\,$ Parts for which "nsp" is indicated on this table cannot be supplied.

* The parts listed below are for maintenance only, might differ from the parts used in the unit in appearances or dimensions.

Note: The symbols in the column	"Remarks" indicate the following destinations.
EQ. Europe and del	

BK : Black model		Europe model Black model	SP : Premium Silver model				$\hat{2}$	
	Ref. No.	Part No.	Part Name	Remarks		Q'ty	New	
	201	nsp	POLY BAG		CPB1A190Z	1	*	
	202	943541007970D	INST MANUAL(E2/EK)		CQX1A1464Z	1	*	2
	203	nsp	S.S.LIST(EX)		-	1		
	204	nsp	BATTERY (SIZE 'AAA')		-	1		
	205	943307007900D	REMOCON(RC1127)		CARTDRAF107BK	1	*	
	206	00D9430113500	ANT.AM LOOP		CSA1A020Z	1	*	
	207	00D9430113403	FM 1 POLE ANT.		CSA1A018Z	1	*	
	208	943429007990S	ANT.DAB T	EK	CSA1A036Z	1	*	
	209	943611000190S	CORD POWER E2	E2	CJA2B108ZV	1	*	
	209	943611000210S	CORD POWER EK	EK	CJA2E106ZV	1	*	
	210	943535007470D	POLY BAG		CPB1A184Z	1	*	2
	211	943533007480D	SNOW PAD		CPS1A852	1	*	
	212	943533007490D	SNOW PAD		CPS1A853	1	*	
	213	943531008000D	OUT CARTON BOX	E2	CPG1A898X	1	*	
	213	943531008010D	OUT CARTON BOX	EK	CPG1A898W	1	*	
	214	nsp	POS LABEL	SPE2	CQB1A943Z	2	*	
	214	nsp	POS LABEL	BKE2	CQB1A943Y	2	*	
	214	nsp	POS LABEL	SPEK	CQB1A943X	2	*	
	214	nsp	POS LABEL	BKEK	CQB1A943W	2	*	
	215	nsp	CONTROL LABEL	SPE2	CQB1A627	2	*	
	215	nsp	CONTROL LABEL	BKE2	CQB1A627	2	*	
	215	nsp	CONTROL LABEL	SPEK	CQB1A627	2	*	
	215	nsp	CONTROL LABEL	BKEK	CQB1A627	2	*	
	216	nsp	COLOR LABEL	SP	CQB1A882Z	1	*	

NOTE FOR SCHEMATIC DIAGRAM

WARNING:

Parts marked with this symbol \triangle have critical characteristics. Use ONLY replacement parts recommended by the manufacturer.

CAUTION:

Before returning the unit to the customer, make sure you make either (1) a leakage current check or (2) a line to chassis resistance check. If the leakage current exceeds 0.5 milliamps, or if the resistance from chassis to either side of the power cord is less than 460 kohms, the unit is defective.

WARNING:

DO NOT return the unit to the customer until the problem is located and corrected.

NOTICE:

ALL RESISTANCE VALUES IN OHM. k=1,000 OHM M=1,000,000 OHM ALL CAPACITANCE VALUES IN MICRO FARAD. P=MICRO-MICRO FARAD EACH VOLTAGE AND CURRENT ARE MEASURED AT NO SIGNAL INPUT CONDITION. CIRCUIT AND PARTS ARE SUBJECT TO CHANGE WITHOUT PRIOR NOTICE.







